

# TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS WITH SHUTDOWN

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

- Supply Current . . . 23  $\mu$ A/Channel
- Gain-Bandwidth Product . . . 220 kHz
- Output Drive Capability . . .  $\pm$ 10 mA
- Input Offset Voltage . . . 20  $\mu$ V (typ)
- V<sub>DD</sub> Range . . . 2.7 V to 6 V
- Power Supply Rejection Ratio . . . 106 dB
- Ultra-Low Power Shutdown Mode  
 $I_{DD}$  . . . 16 nA/ch
- Rail-To-Rail Input/Output (RRIO)
- Ultra-Small Packaging
  - 5 or 6 Pin SOT-23 (TLV2450/1)
  - 8 or 10 Pin MSOP (TLV2452/3)

## description

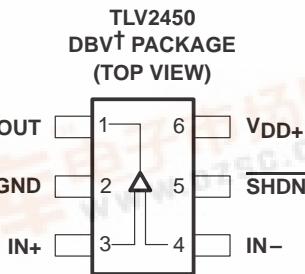
The TLV245x is a family of rail-to-rail input/output operational amplifiers that set a new performance point for supply current and ac performance. These devices consume a mere 23  $\mu$ A/channel while offering 220 kHz of gain bandwidth product; much higher than competitive devices with similar supply current levels. Along with increased ac performance, the amplifier provides high output drive capability, solving a major shortcoming of older micropower rail-to-rail input/output operational amplifiers. The TLV245x can swing to within 250 mV of each supply rail while driving a 2.5-mA load. Both the inputs and outputs swing rail-to-rail for increased dynamic range in low-voltage applications. This performance makes the TLV245x family ideal for portable medical equipment, patient monitoring systems, and data acquisition circuits.

Three members of the family (TLV2450/3/5) offer a shutdown terminal for conserving battery life in portable applications. During shutdown, the outputs are placed in a high-impedance state and the amplifier consumes only 16 nA/channel. The family is fully specified at 3 V and 5 V across an expanded industrial temperature range ( $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ). The singles and duals are available in the SOT23 and MSOP packages, while the quads are available in TSSOP. The TLV2450 offers an amplifier with shutdown functionality all in a 6-pin SOT23 package, making it perfect for high density circuits.

FAMILY PACKAGE TABLE

DEVICE	NUMBER OF CHANNELS	PACKAGE TYPES					SHUTDOWN	UNIVERSAL EVM BOARD
		PDIP	SOIC	SOT-23	TSSOP	MSOP		
TLV2450	1	8	8	6 <sup>‡</sup>	—	—	Yes	UNIV-OPAMP-2
TLV2451	1	8	8	5	—	—	—	UNIV-OPAMP-1
TLV2452	2	8	8	—	—	8	—	UNIV-OPAMP-1
TLV2453	2	14	14	—	—	10	Yes	UNIV-OPAMP-2
TLV2454	4	14	14	—	14	—	—	—
TLV2455	4	16	16	—	16	—	Yes	—

<sup>‡</sup>This device is in the Product Preview stage of development. Contact your local TI sales office for availability.



†This device is in the Product Preview stage of development. Please contact your local TI sales office for availability.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

This document contains information on products in more than one phase of development. The status of each device is indicated on the page(s) specifying its electrical characteristics.

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TLV2450 and TLV2451 AVAILABLE OPTIONS**

TA	PACKAGED DEVICES				CHIP FORM‡ (Y)	
	SMALL OUTLINE (D)†	SOT-23		PLASTIC DIP (P)		
		(DBV)†	SYMBOL			
0°C to 70°C	TLV2450CD\$ TLV2451CD	TLV2450CDBV TLV2451CDBV	VAQC VARC	TLV2450CP TLV2451CP	TLV2450Y TLV2451Y	
–40°C to 125°C	TLV2450ID\$ TLV2451ID	TLV2450IDBV TLV2451IDBV	VAQI VARI	TLV2450IP TLV2451IP	— —	
	TLV2450AID TLV2451AID	— —	— —	TLV2450AIP TLV2451AIP	— —	

† This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2450CDR).

‡ Chip forms are tested at TA = 25°C only.

\$ This device is in the Product Preview stage of development. Contact your local TI sales office for availability.

**TLV2452 and TLV2453 AVAILABLE OPTIONS**

TA	PACKAGED DEVICES						CHIP FORM‡ (Y)	
	SMALL OUTLINE (D)†	MSOP			PLASTIC DIP (N)	PLASTIC DIP (P)		
		(DGK)†	SYMBOL§	(DGS)†	SYMBOL§			
0°C to 70°C	TLV2452CD TLV2453CD	TLV2452CDGK —	xxTIABI —	— TLV2453CDGS	— xxTIABK	— TLV2453CN	TLV2452CP —	
–40°C to 125°C	TLV2452ID TLV2453ID	TLV2452IDGK —	xxTIABJ —	— TLV2453IDGS	— xxTIABL	— TLV2453IN	TLV2452IP —	
	TLV2452AID TLV2453AID	— —	— —	— —	— —	— TLV2453AIN	TLV2452AIP —	

† This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2452CDR).

‡ Chip forms are tested at TA = 25°C only.

§ xx represents the device date code.

**TLV2454 and TLV2455 AVAILABLE OPTIONS**

TA	PACKAGED DEVICES			CHIP FORM‡ (Y)
	SMALL OUTLINE (D)†	PLASTIC DIP (N)	TSSOP (PW)†	
0°C to 70°C	TLV2454CD TLV2455CD	TLV2454CN TLV2455CN	TLV2454CPW TLV2455CPW	TLV2454Y TLV2455Y
–40°C to 125°C	TLV2454ID TLV2455ID	TLV2454IN TLV2455IN	TLV2454IPW TLV2455IPW	— —
	TLV2454AID TLV2455AID	TLV2454AIN TLV2455AIN	TLV2454AIPW TLV2455AIPW	— —

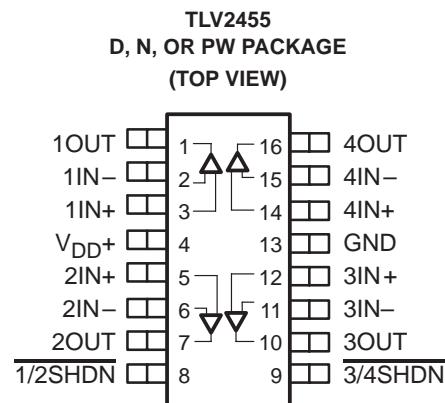
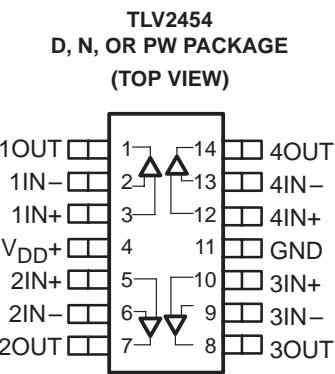
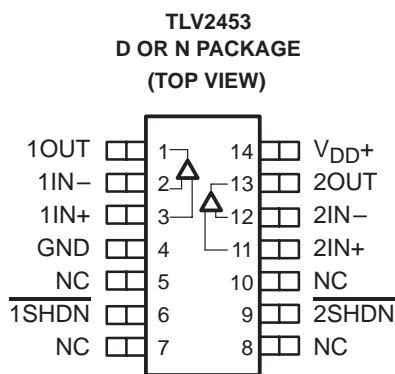
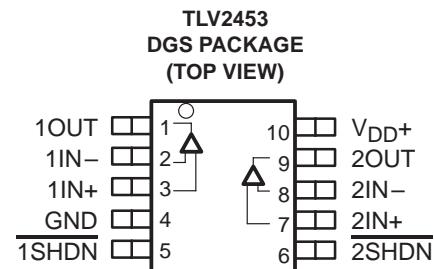
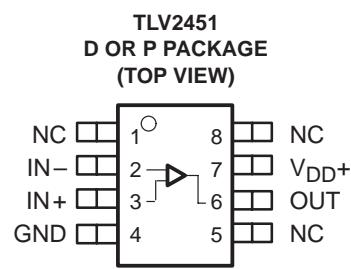
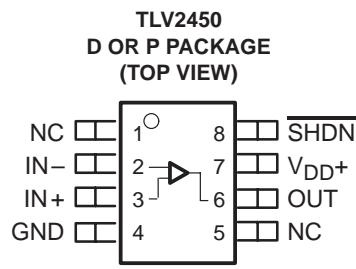
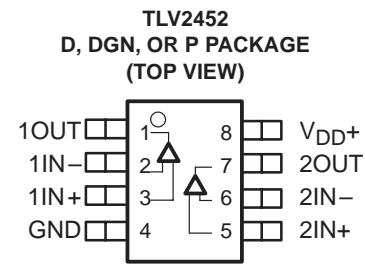
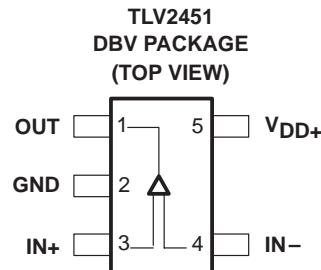
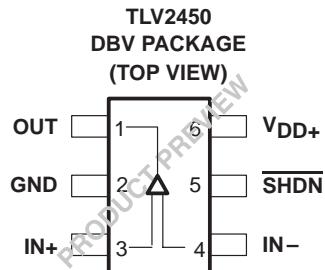
† This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2454CDR).

‡ Chip forms are tested at TA = 25°C only.

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TLV245x PACKAGE PINOUTS**



NC – No internal connection

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>**

Supply voltage, $V_{DD}$ (see Note 1) .....	7 V
Differential input voltage, $V_{ID}$ .....	$\pm V_{DD}$
Continuous total power dissipation .....	See Dissipation Rating Table
Operating free-air temperature range, $T_A$ : C suffix .....	0°C to 70°C
I suffix .....	-40°C to 125°C
Maximum junction temperature, $T_J$ .....	150°C
Storage temperature range, $T_{STG}$ .....	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds .....	260°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE: All voltage values, except differential voltages, are with respect to  $V_{DD} -$ .

**DISSIPATION RATING TABLE**

PACKAGE	$\theta_{JC}$ (°C/W)	$\theta_{JA}$ (°C/W)	$T_A \leq 25^\circ\text{C}$ POWER RATING
D (8)	38.3	176	710 mW
D (14)	26.9	122.3	1022 mW
D (16)	25.7	114.7	1090 mW
DBV (5)	55	324.1	385 mW
DBV (6)	55	294.3	425 mW
DGK (8)	54.2	259.9	481 mW
DGS (10)	54.1	257.7	485 mW
N (14, 16)	32	78	1600 mW
P (8)	41	104	1200 mW
PW (14)	29.3	173.6	720 mW
PW (16)	28.7	161.4	774 mW

**recommended operating conditions**

		MIN	MAX	UNIT
Supply voltage, $V_{DD}$	Single supply	2.7	6	V
	Split supply	$\pm 1.35$	$\pm 3$	
Common-mode input voltage range, $V_{ICR}$		$V_{DD} -$	$V_{DD} +$	V
Operating free-air temperature, $T_A$	C-suffix	0	70	°C
	I-suffix	-40	125	

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**electrical characteristics at specified free-air temperature,  $V_{DD} = 3$  V (unless otherwise noted)**

PARAMETER		TEST CONDITIONS		TA <sup>†</sup>	MIN	TYP	MAX	UNIT			
V <sub>IO</sub>	Input offset voltage	TLV245x	$V_{DD} = \pm 1.5$ V $V_{IC} = 0$ , $V_O = 0$ , $R_S = 50 \Omega$	25°C	20	1500		$\mu$ V			
				Full range		2000					
	Temperature coefficient of input offset voltage			25°C	20	1000					
				Full range		1300					
$\alpha_{VIO}$	Temperature coefficient of input offset voltage					0.3		$\mu$ V/°C			
	I <sub>IO</sub>	TLV245xA		25°C	0.3	4.5		nA			
				Full range		5.5					
I <sub>IB</sub>	Input bias current			25°C	0.9	5		nA			
				Full range		7					
	Common-mode input voltage range	V <sub>ICR</sub>	CMRR > 70 dB	$R_S = 50 \Omega$	25°C	0		V			
			CMRR > 52 dB	$R_S = 50 \Omega$	Full range	0					
V <sub>OH</sub>	High-level output voltage		$V_{IC} = 1.5$ V, $I_{OL} = -500 \mu$ A	25°C	2.85	2.95		V			
				Full range	2.83						
V <sub>OL</sub>	Low-level output voltage		$V_{IC} = 1.5$ V, $I_{OL} = 500 \mu$ A	25°C	0.09	0.16		V			
				Full range		0.2					
I <sub>OS</sub>	Short-circuit output current	Sourcing		25°C	4	12		mA			
				Full range	3						
		Sinking		25°C	2	7					
				Full range	1						
I <sub>O</sub>	Output current	$V_O = 0.5$ V from rail		25°C		±4		mA			
A <sub>VD</sub>	Large-signal differential voltage amplification	$V_O(PP) = 1$ V, $R_L = 10 \text{ k}\Omega$		25°C	96	110		dB			
				Full range	91						
r <sub>i(d)</sub>	Differential input resistance			25°C		10 <sup>9</sup>		$\Omega$			
C <sub>IC</sub>	Common-mode input capacitance	$f = 10$ kHz		25°C		4.5		pF			
$z_0$	Closed-loop output impedance	$f = 10$ kHz, $A_V = 10$		25°C		80		$\Omega$			
CMRR	Common-mode rejection ratio	$V_{IC} = 0$ to $3$ V, $R_S = 50 \Omega$	TLV245xC	Full range	60			dB			
			TLV245xI		52						
k <sub>SVR</sub>	Supply voltage rejection ratio ( $\Delta V_{DD} / \Delta V_{IO}$ )	V <sub>DD</sub> = 2.7 V to 6 V, No load	$V_{IC} = V_{DD}/2$ ,	25°C	76	89		dB			
				Full range	74						
		V <sub>DD</sub> = 3 V to 5 V, No load	$V_{IC} = V_{DD}/2$ ,	25°C	88	106					
				Full range	84						

<sup>†</sup> Full range is 0°C to 70°C for C suffix and –40°C to 125°C for I suffix.

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**electrical characteristics at specified free-air temperature,  $V_{DD} = 3$  V (unless otherwise noted)  
(continued)**

PARAMETER	TEST CONDITIONS		$T_A^\dagger$	MIN	TYP	MAX	UNIT
$I_{DD}$ Supply current (per channel)	$V_O = 1.5$ V, No load	TLV245xC	25°C		23	35	$\mu$ A
			Full range		40		
		TLV245xI	Full range		45		
$V_{(ON)}$ Turnon voltage level	$A_V = 1$		25°C		1.73		V
$V_{(OFF)}$ Turnoff voltage level	$A_V = 1$		25°C		1.45		V
$I_{DD(SHDN)}$ Supply current in shutdown mode (TLV2450, TLV2453, TLV2455) (per channel)	$SHDN = < 1.45$ V	TLV245xC	25°C		12	70	nA
			Full range		70		
		TLV245xI	Full range		80		

<sup>†</sup> Full range is 0°C to 70°C for C suffix and –40°C to 125°C for I suffix.

**operating characteristics at specified free-air temperature,  $V_{DD} = 3$  V (unless otherwise noted)**

PARAMETER	TEST CONDITIONS		$T_A^\dagger$	MIN	TYP	MAX	UNIT
SR Slew rate at unity gain	$V_O(PP) = 0.8$ V, $C_L = 150$ pF, $R_L = 10$ k $\Omega$	$A_V = 1$	25°C	0.05	0.11		V/ $\mu$ s
			Full range		0.02		
$V_n$ Equivalent input noise voltage	$f = 100$ Hz		25°C		49		nV/ $\sqrt{\text{Hz}}$
			$f = 1$ kHz		51		
$I_n$ Equivalent input noise current	$f = 1$ kHz		25°C		3.5		pA/ $\sqrt{\text{Hz}}$
THD + N Total harmonic distortion plus noise	$V_O(PP) = 1.5$ V, $R_L = 10$ k $\Omega$ , $f = 1$ kHz	$A_V = 1$	25°C		0.04%		$\mu$ s
		$A_V = 10$			0.3%		
		$A_V = 100$			1.5%		
t(on) Amplifier turnon time	$A_V = 5$ , $R_L = \text{OPEN}$ ,		25°C		59		$\mu$ s
t(off) Amplifier turnoff time	Measured at 50% point		25°C		836		ns
Gain-bandwidth product		$f = 10$ kHz, $R_L = 10$ k $\Omega$	25°C		200		kHz
$t_s$ Settling time	$V_{(STEP)PP} = 2$ V, $A_V = -1$ , $C_L = 10$ pF, $R_L = 10$ k $\Omega$	0.1%	25°C		26		$\mu$ s
		0.01%			31		
	$V_{(STEP)PP} = 2$ V, $A_V = -1$ , $C_L = 56$ pF, $R_L = 10$ k $\Omega$	0.1%			26		
		0.01%			31		
$\phi_m$ Phase margin	$R_L = 10$ k $\Omega$ , $C_L = 1000$ pF		25°C		56°		
	$R_L = 10$ k $\Omega$ , $C_L = 1000$ pF		25°C		7		dB

<sup>†</sup> Full range is 0°C to 70°C for C suffix and –40°C to 125°C for I suffix.

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**electrical characteristics at specified free-air temperature,  $V_{DD} = 5$  V (unless otherwise noted)**

PARAMETER		TEST CONDITIONS		TA <sup>†</sup>	MIN	TYP	MAX	UNIT			
V <sub>IO</sub>	Input offset voltage	TLV245x	$V_{DD} = \pm 2.5$ V $V_{IC} = 0$ , $V_O = 0$ , $R_S = 50 \Omega$	25°C	20	1500		$\mu$ V			
				Full range		2000					
	Temperature coefficient of input offset voltage			25°C	20	1000					
				Full range		1300					
$\alpha_{VIO}$	Temperature coefficient of input offset voltage					0.3		$\mu$ V/°C			
	I <sub>IO</sub>	TLV245xA		25°C	0.3	4.5		nA			
				Full range		5.5					
I <sub>IB</sub>	Input bias current			25°C	0.5	5		nA			
				Full range		7					
	Common-mode input voltage range		CMRR > 70 dB	$R_S = 50 \Omega$	25°C	0		V			
			CMRR > 52 dB	$R_S = 50 \Omega$	Full range	0					
V <sub>OH</sub>	High-level output voltage		$V_{IC} = 2.5$ V, $I_{OH} = -500 \mu$ A	25°C	4.87	4.97		V			
				Full range	4.85						
V <sub>OL</sub>	Low-level output voltage		$V_{IC} = 2.5$ V, $I_{OL} = 500 \mu$ A	25°C	0.07	0.15		V			
				Full range		0.16					
I <sub>OS</sub>	Short-circuit output current	Sourcing		25°C	20	32		mA			
				Full range	18						
		Sinking		25°C	12	18					
				Full range	10						
I <sub>O</sub>	Output current	$V_O = 0.5$ V from rail		25°C		±10		mA			
A <sub>VD</sub>	Large-signal differential voltage amplification	$V_O(PP) = 3$ V,	$R_L = 10 \text{ k}\Omega$	25°C	96	103		dB			
				Full range	91						
r <sub>i(d)</sub>	Differential input resistance			25°C		10 <sup>9</sup>		$\Omega$			
C <sub>IC</sub>	Common-mode input capacitance	$f = 10$ kHz		25°C		4.5		pF			
$z_0$	Closed-loop output impedance	$f = 10$ kHz, $A_V = 10$		25°C		45		$\Omega$			
CMRR	Common-mode rejection ratio	$V_{IC} = 0$ to $5$ V, $R_S = 50 \Omega$	TLV245xC	Full range	66			dB			
			TLV245xI		52						
k <sub>SVR</sub>	Supply voltage rejection ratio ( $\Delta V_{DD} / \Delta V_{IO}$ )	V <sub>DD</sub> = 2.7 V to 6 V, No load	$V_{IC} = V_{DD}/2$ ,	25°C	76	89		dB			
				Full range	74						
		V <sub>DD</sub> = 3 V to 5 V, No load	$V_{IC} = V_{DD}/2$ ,	25°C	88	106					
				Full range	84						

<sup>†</sup> Full range is 0°C to 70°C for C suffix and –40°C to 125°C for I suffix.

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**electrical characteristics at specified free-air temperature,  $V_{DD} = 5$  V (unless otherwise noted)  
(continued)**

PARAMETER	TEST CONDITIONS		$T_A^\dagger$	MIN	TYP	MAX	UNIT
$I_{DD}$ Supply current (per channel)	$V_O = 2.5$ V, No load	TLV245xC	25°C		23	42	$\mu$ A
			Full range		44		
		TLV245xI	Full range		46		
$V_{(ON)}$ Turnon voltage level	$A_V = 1$		25°C		1.73		V
$V_{(OFF)}$ Turnoff voltage level	$A_V = 1$		25°C		1.45		V
$I_{DD(SHDN)}$ Supply current in shutdown mode (TLV2450, TLV2453, TLV2455) (per channel)	$SHDN = < 1.45$ V	TLV245xC	25°C		16	65	nA
			Full range		65		
		TLV245xI	Full range		80		

<sup>†</sup> Full range is 0°C to 70°C for C suffix and –40°C to 125°C for I suffix.

**operating characteristics at specified free-air temperature,  $V_{DD} = 5$  V (unless otherwise noted)**

PARAMETER	TEST CONDITIONS		$T_A^\dagger$	MIN	TYP	MAX	UNIT	
SR Slew rate at unity gain	$V_O(PP) = 2$ V, $R_L = 10$ k $\Omega$	$C_L = 150$ pF, $R_L = 10$ k $\Omega$	25°C	0.05	0.11		V/ $\mu$ s	
			Full range	0.02				
$V_n$ Equivalent input noise voltage	$f = 100$ Hz		25°C		49		nV/ $\sqrt{\text{Hz}}$	
			$f = 1$ kHz		52			
$I_n$ Equivalent input noise current	$f = 1$ kHz		25°C		3.5		pA/ $\sqrt{\text{Hz}}$	
THD + N Total harmonic distortion plus noise	$V_O(PP) = 3$ V, $R_L = 10$ k $\Omega$ , $f = 1$ kHz	$A_V = 1$ $A_V = 10$ $A_V = 100$	25°C		0.02%		$\mu$ s	
					0.18%			
					0.9%			
t(on) Amplifier turnon time	$A_V = 5$ ,		25°C		59		$\mu$ s	
t(off) Amplifier turnoff time	$R_L = \text{OPEN}$ , Measured at 50% point				836		ns	
Gain-bandwidth product		$f = 10$ kHz, $R_L = 10$ k $\Omega$	25°C		220		kHz	
$t_s$ Settling time	$V_{(STEP)PP} = 2$ V, $A_V = -1$ , $C_L = 10$ pF, $R_L = 10$ k $\Omega$	0.1%	25°C		24		$\mu$ s	
		0.01%			30			
	$V_{(STEP)PP} = 2$ V, $A_V = -1$ , $C_L = 56$ pF, $R_L = 10$ k $\Omega$	0.1%			25			
		0.01%			30			
$\phi_m$ Phase margin	$R_L = 10$ k $\Omega$ , $C_L = 1000$ pF		25°C		56°			
	$R_L = 10$ k $\Omega$ , $C_L = 1000$ pF		25°C		7		dB	

<sup>†</sup> Full range is 0°C to 70°C for C suffix and –40°C to 125°C for I suffix.

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**

**Table of Graphs**

			<b>FIGURE</b>
$V_{IO}$	Input offset voltage	vs Common-mode input voltage	1, 2
$I_{IO}$	Input offset current	vs Common-mode input voltage	3, 4
		vs Free-air temperature	7, 8
$I_{IB}$	Input bias current	vs Common-mode input voltage	5, 6
		vs Free-air temperature	7, 8
$A_{VD}$	Differential voltage amplification	vs Frequency	9, 10
		Phase	9, 10
$V_{OL}$	Low-level output voltage	vs Low-level output current	11, 13
$V_{OH}$	High-level output voltage	vs High-level output current	12, 14
$Z_o$	Output impedance	vs Frequency	15, 16
CMRR	Common-mode rejection ratio	vs Frequency	17
PSRR	Power supply rejection ratio	vs Frequency	18
$I_{DD}$	Supply current	vs Supply voltage	19
		vs Free-air temperature	20
$V_n$	Equivalent input noise voltage	vs Frequency	21
$THD + N$	Total harmonic distortion plus noise	vs Frequency	22, 23
$\phi_m$	Phase margin	vs Load capacitance	24
		vs Supply voltage	25
SR	Slew rate	vs Supply voltage	26
		vs Free-air temperature	27
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency	28
		Crosstalk	29, 30
	Small-signal follower pulse response	vs Time	31, 33
		Large-signal follower pulse response	32, 34
	Shutdown on supply current	vs Time	35
		Shutdown off supply current	36
	Shutdown supply current	vs Free-air temperature	37
		vs Time	38 – 41
	Shutdown pulse	vs Time	38 – 41
		Shutdown off pulse response	42, 43
	Shutdown on pulse response	vs Time	44, 45
		Shutdown reverse isolation	46
	Shutdown forward isolation	vs Frequency	47

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA**  
**FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT**  
**OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**

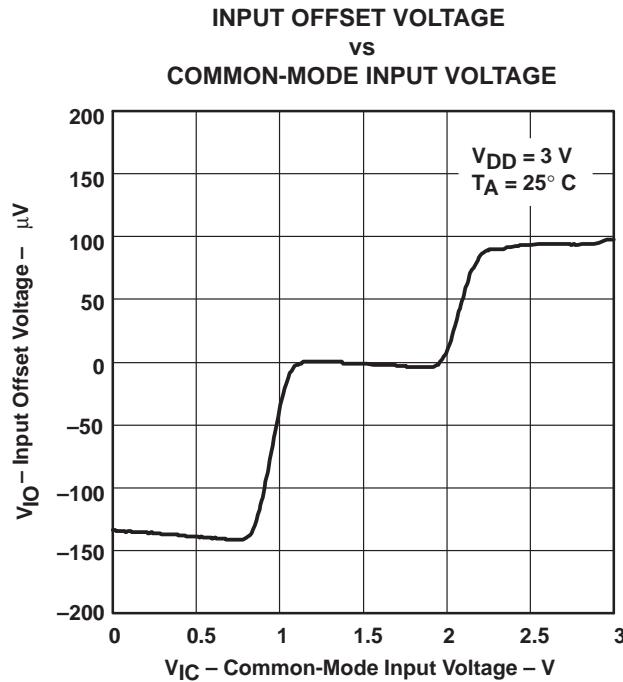


Figure 1

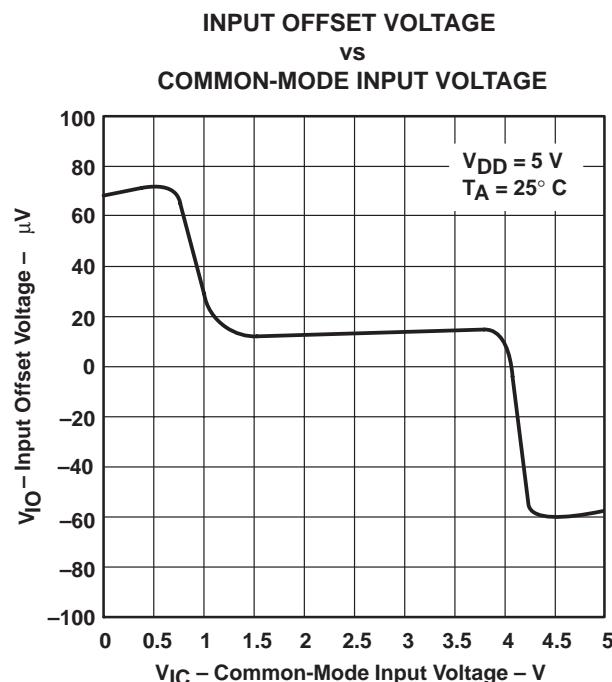


Figure 2

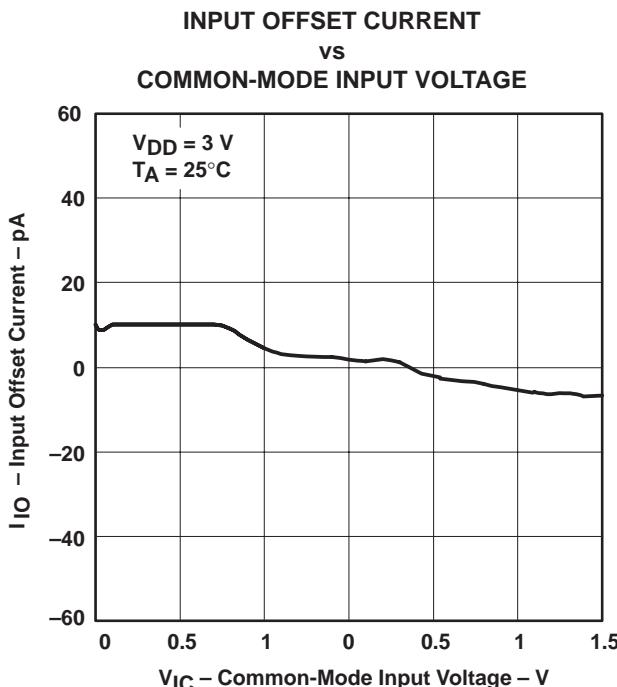


Figure 3

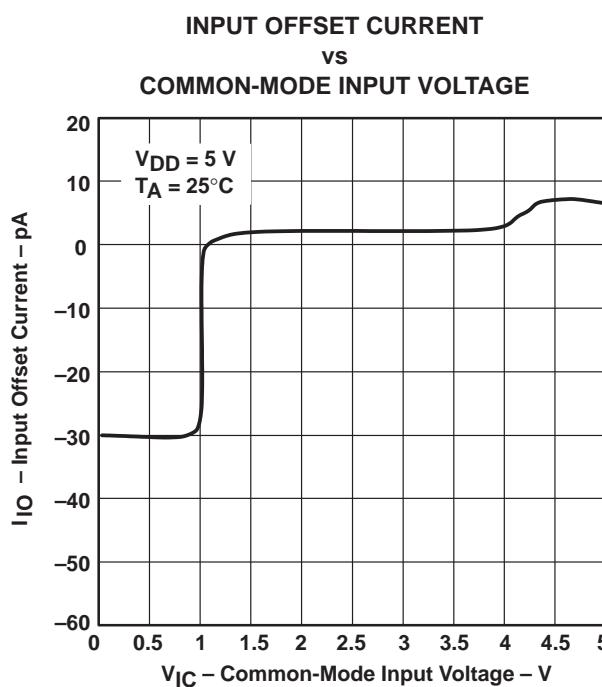


Figure 4

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**

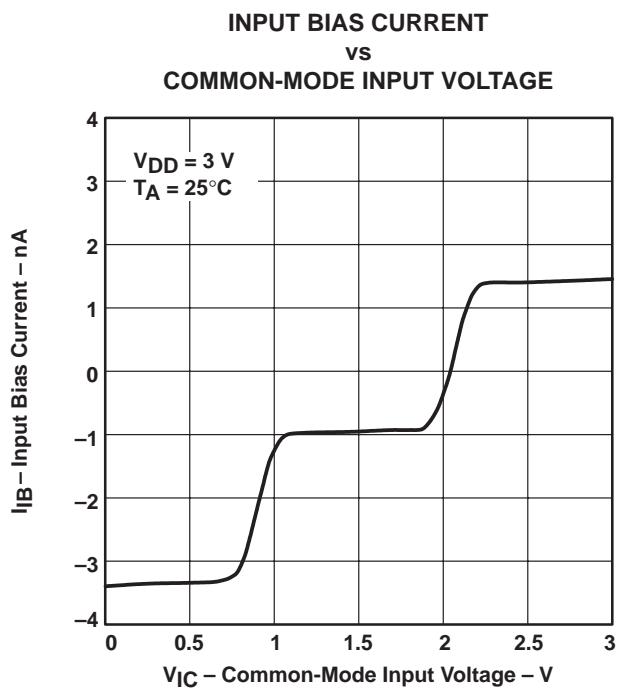


Figure 5

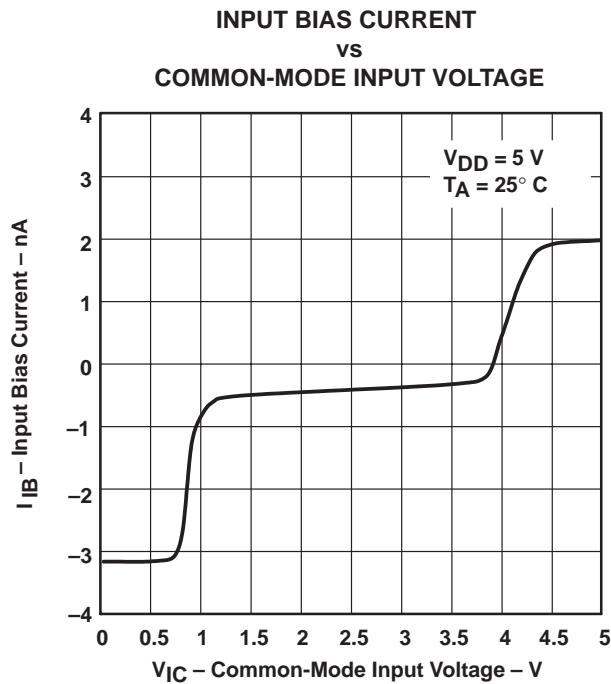


Figure 6

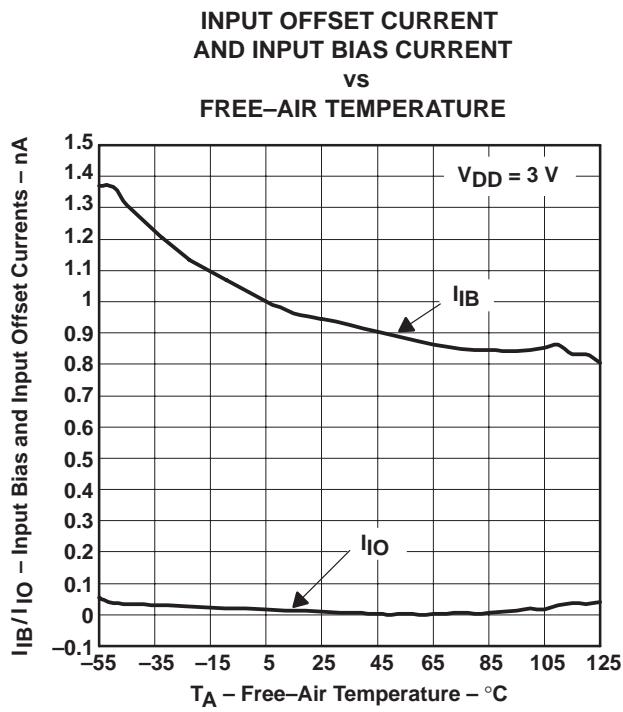


Figure 7

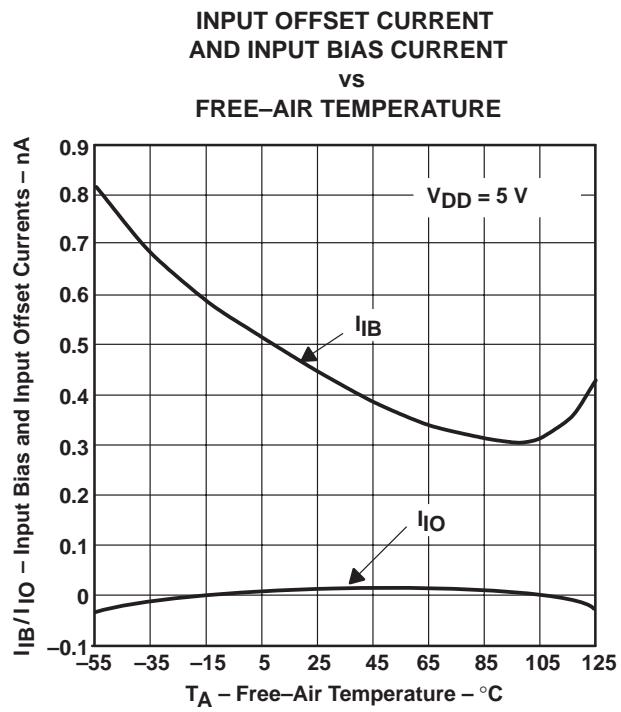


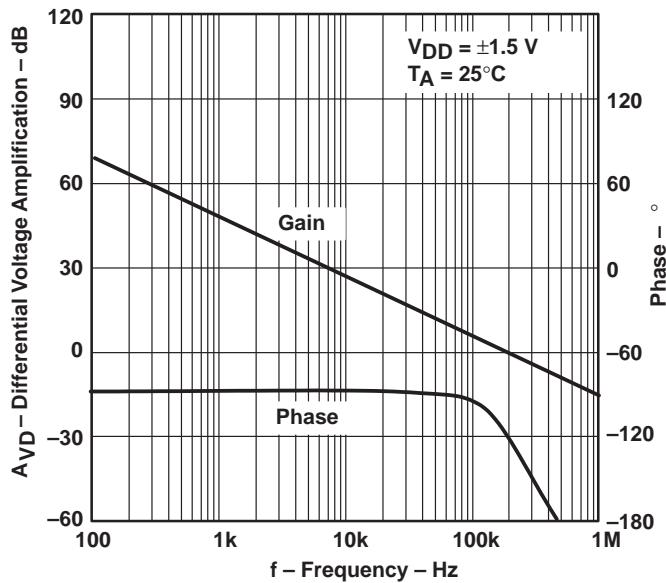
Figure 8

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

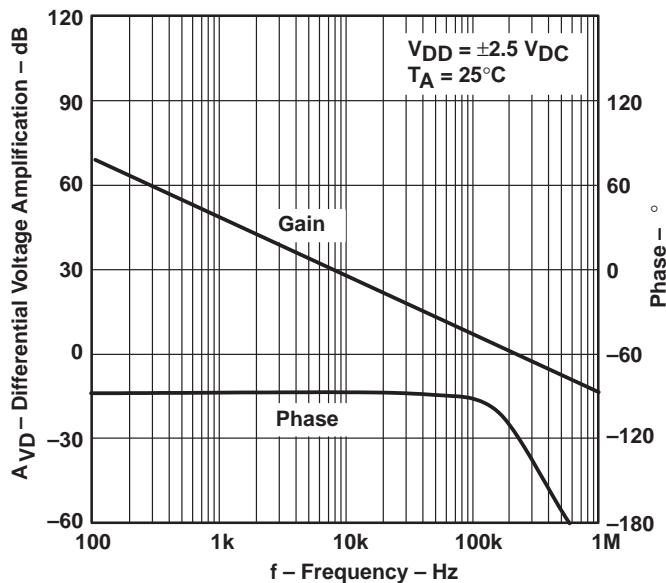
**TYPICAL CHARACTERISTICS**

**DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE  
vs  
FREQUENCY**



**Figure 9**

**DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE  
vs  
FREQUENCY**



**Figure 10**

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**

**LOW-LEVEL OUTPUT VOLTAGE  
vs  
LOW-LEVEL OUTPUT CURRENT**

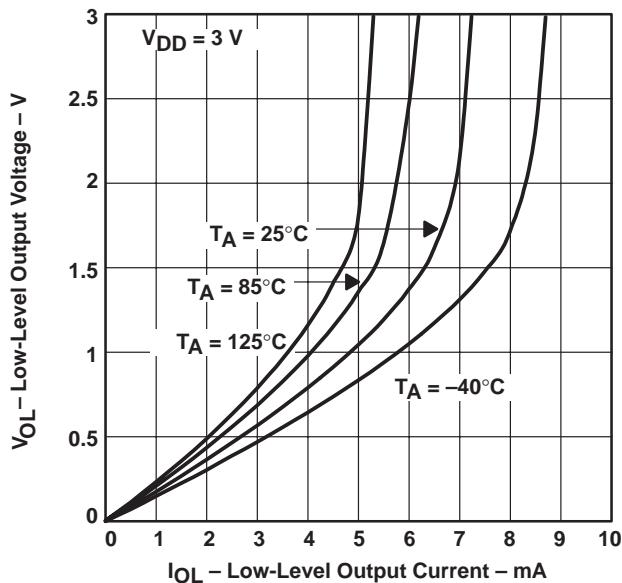


Figure 11

**HIGH-LEVEL OUTPUT VOLTAGE  
vs  
HIGH-LEVEL OUTPUT CURRENT**

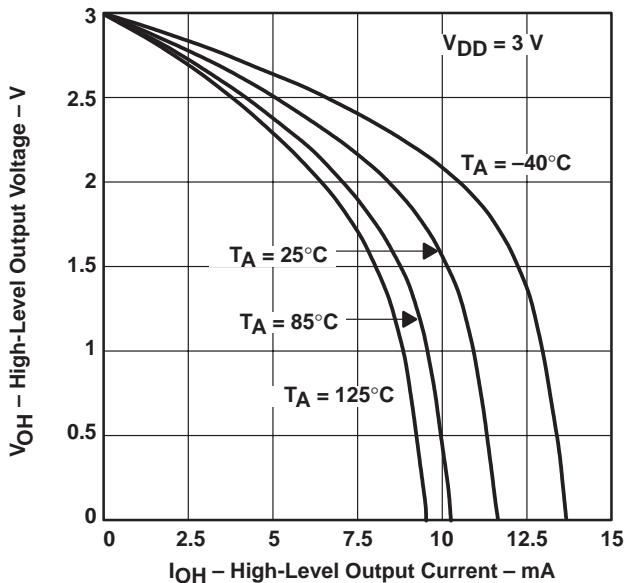


Figure 12

**LOW-LEVEL OUTPUT VOLTAGE  
vs  
LOW-LEVEL OUTPUT CURRENT**

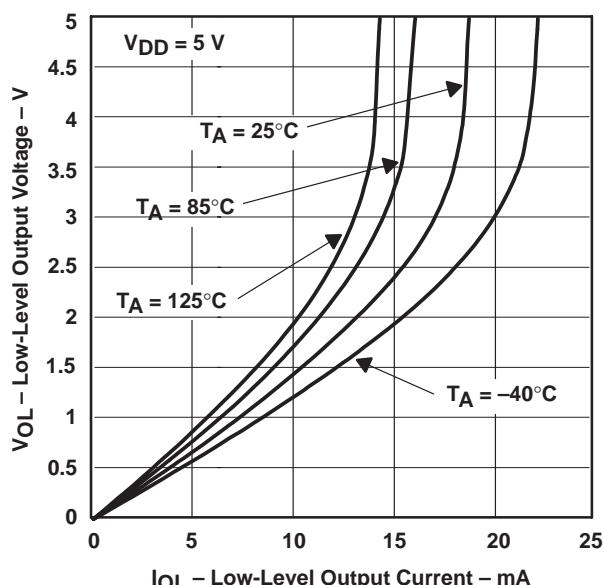


Figure 13

**HIGH-LEVEL OUTPUT VOLTAGE  
vs  
HIGH-LEVEL OUTPUT CURRENT**

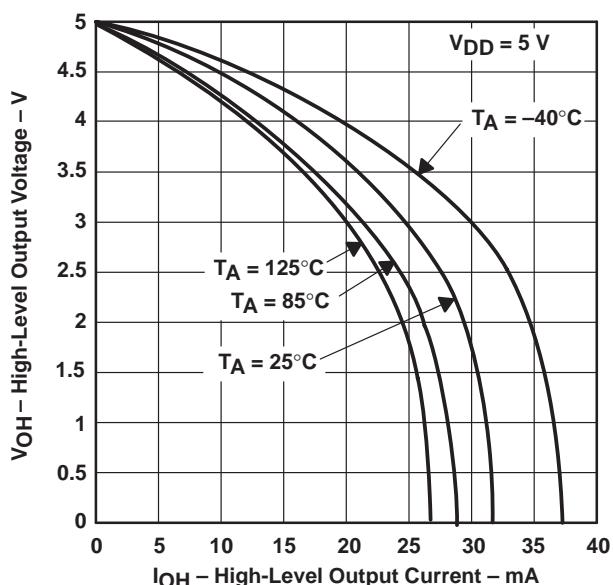
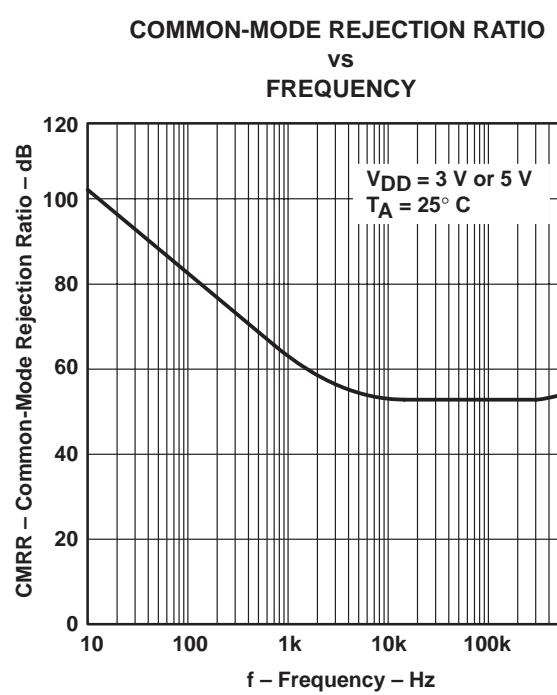
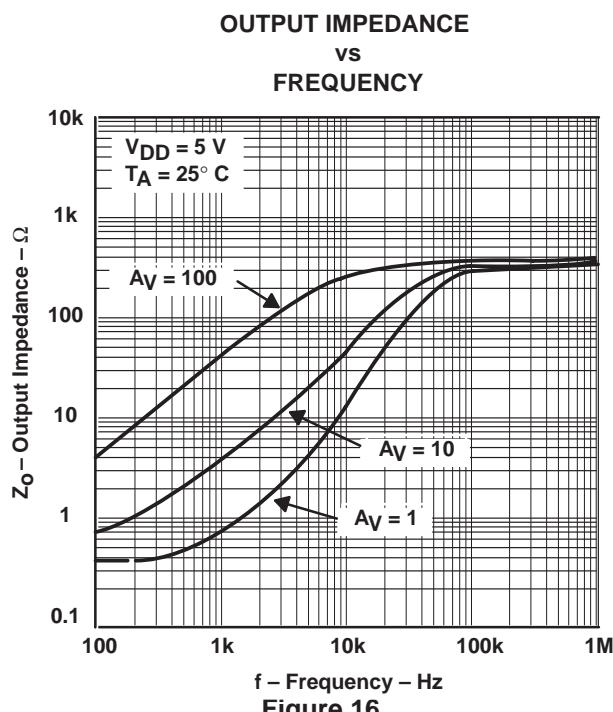
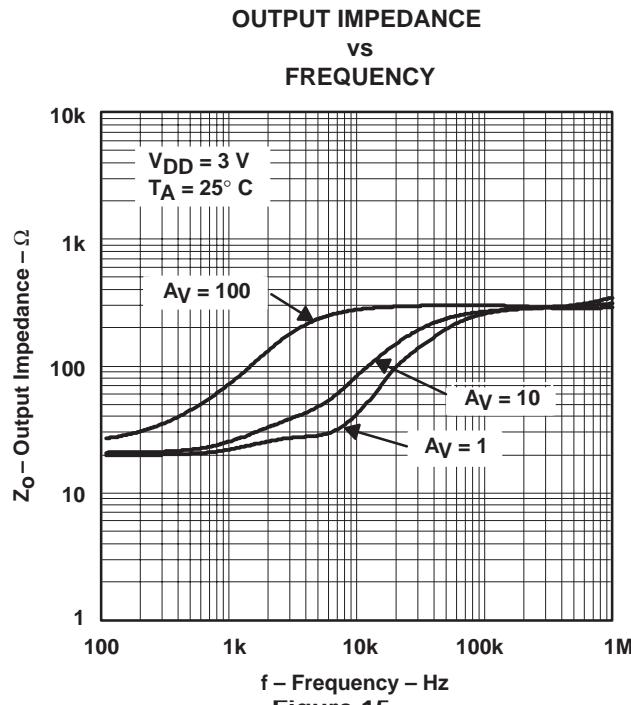


Figure 14

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA**  
**FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT**  
**OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**



**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**

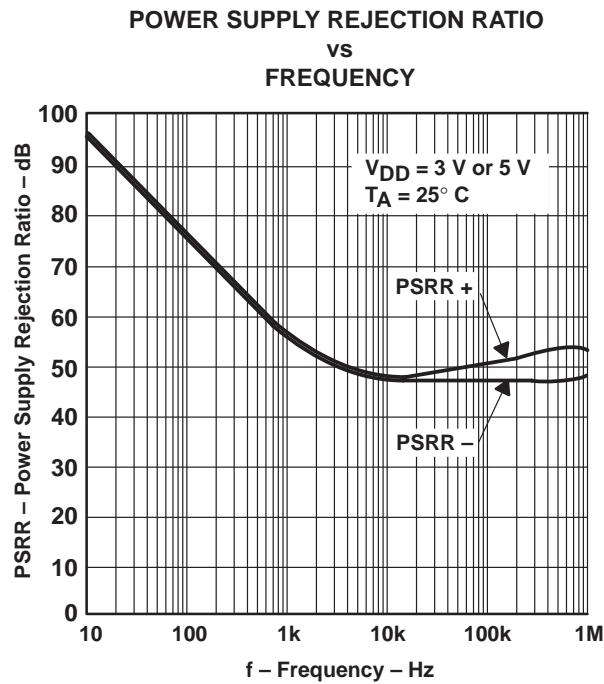


Figure 18

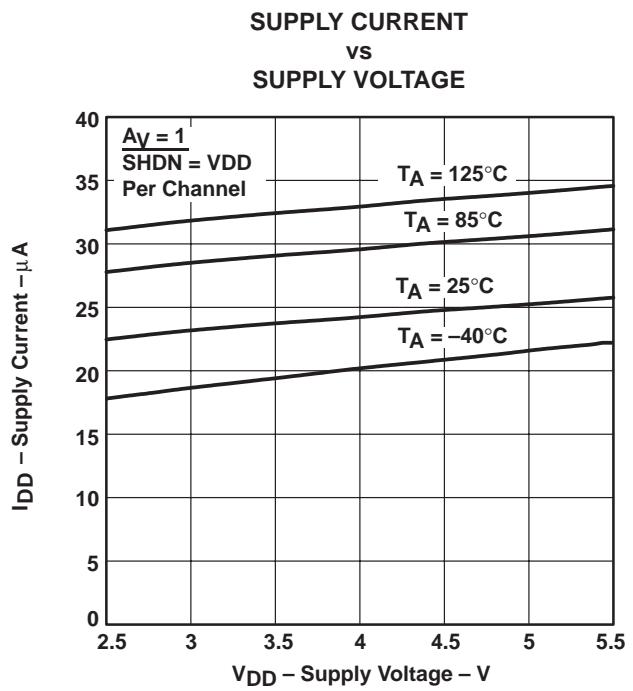


Figure 19

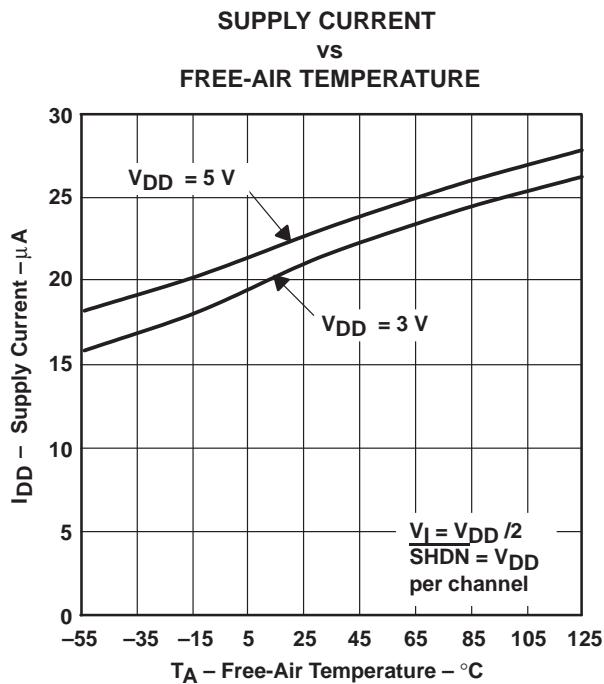


Figure 20

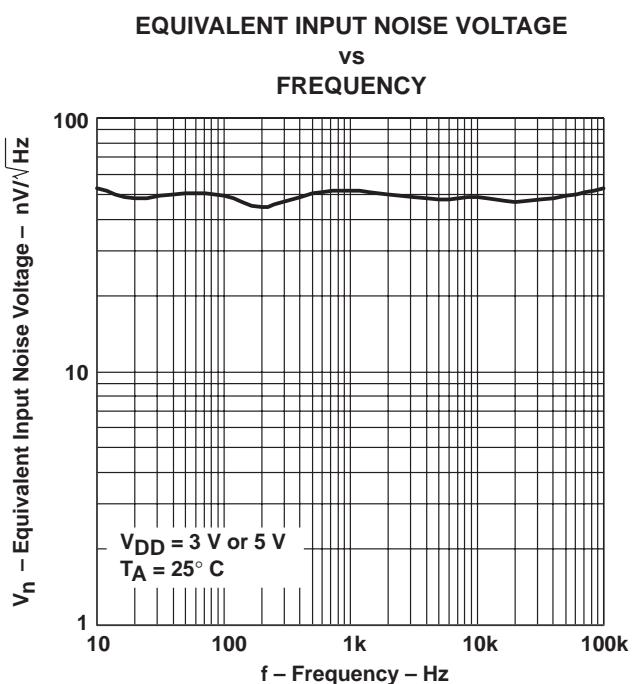


Figure 21

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA**  
**FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT**  
**OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**

**TOTAL HARMONIC DISTORTION PLUS NOISE  
vs  
FREQUENCY**

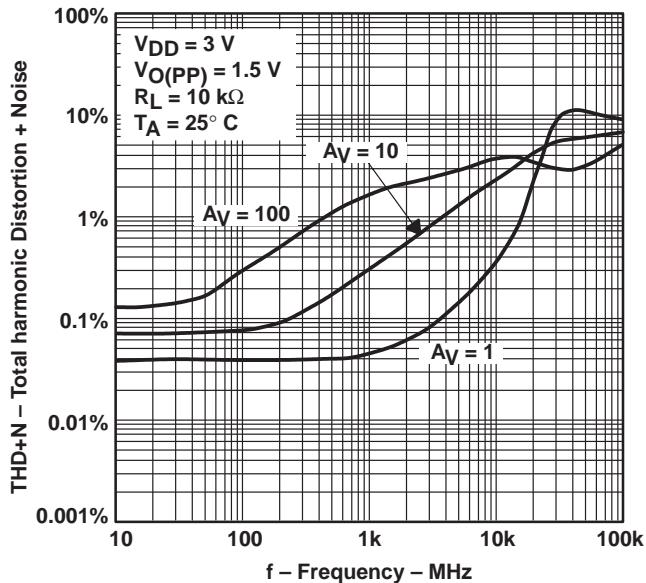


Figure 22

**TOTAL HARMONIC DISTORTION PLUS NOISE  
vs  
FREQUENCY**

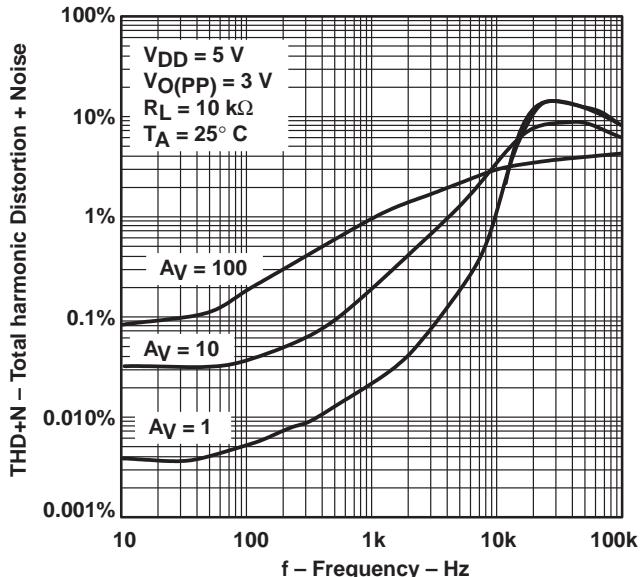


Figure 23

**PHASE MARGIN  
vs  
LOAD CAPACITANCE**

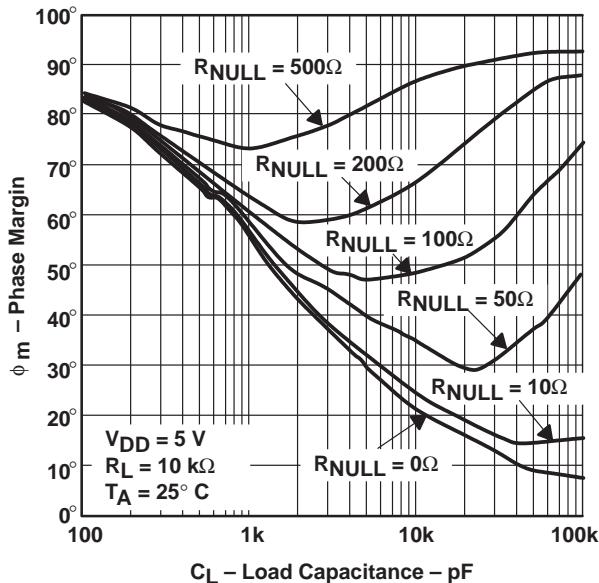


Figure 24

**GAIN BANDWIDTH PRODUCT  
vs  
SUPPLY VOLTAGE**

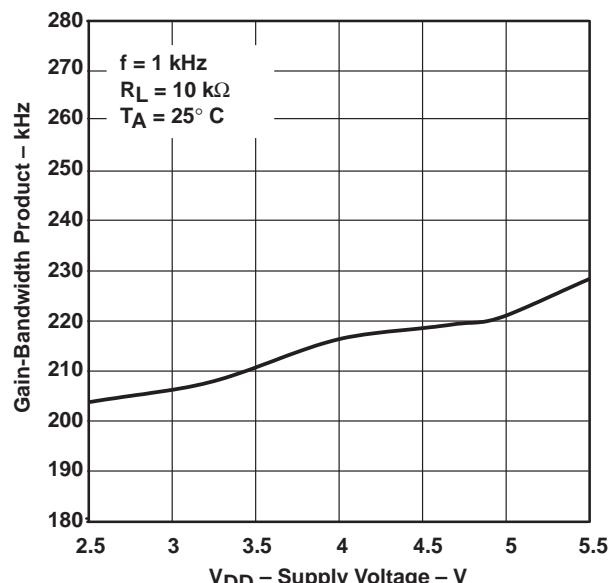


Figure 25

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**

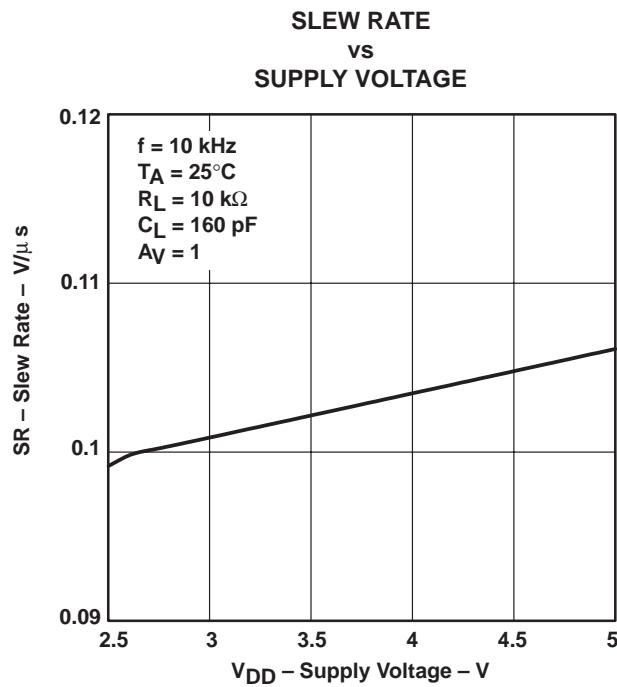


Figure 26

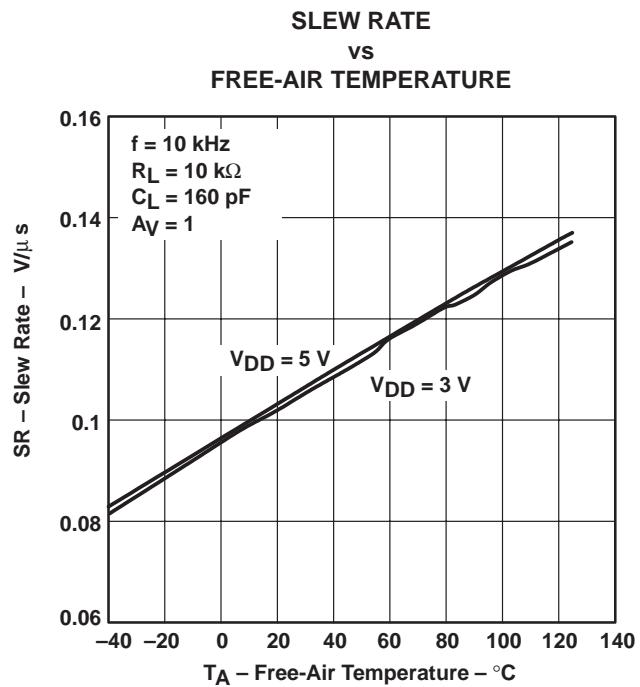


Figure 27

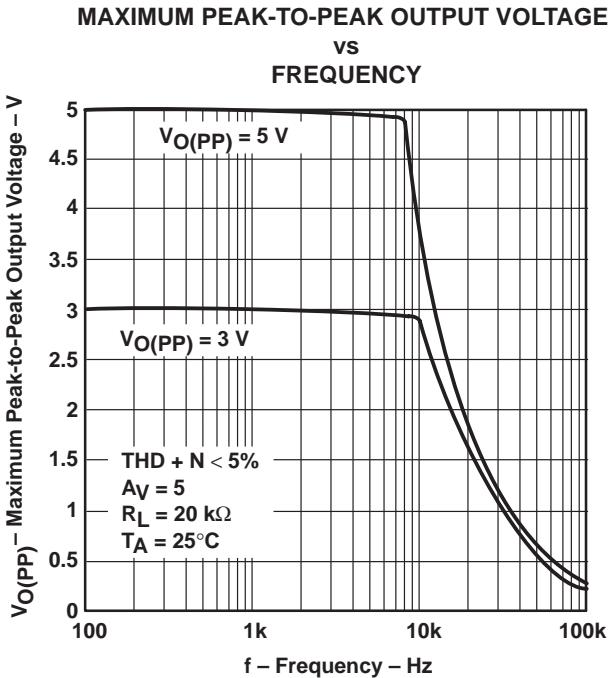


Figure 28

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA**  
**FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT**  
**OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**

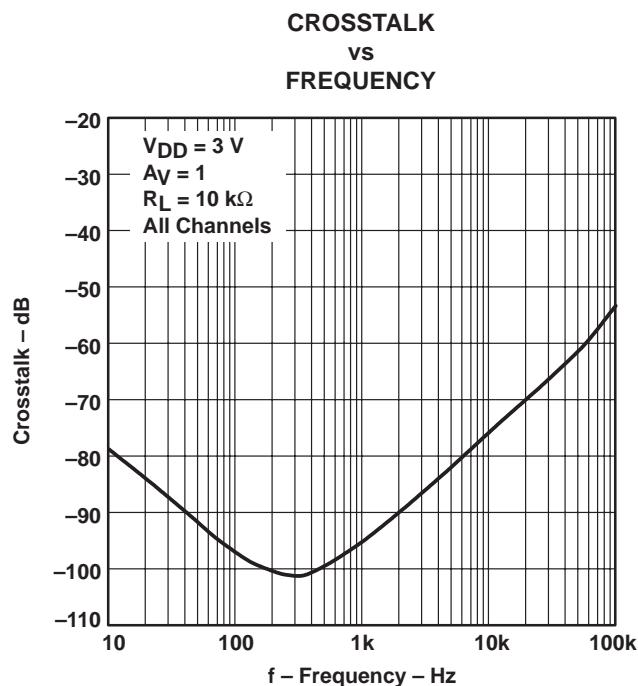


Figure 29

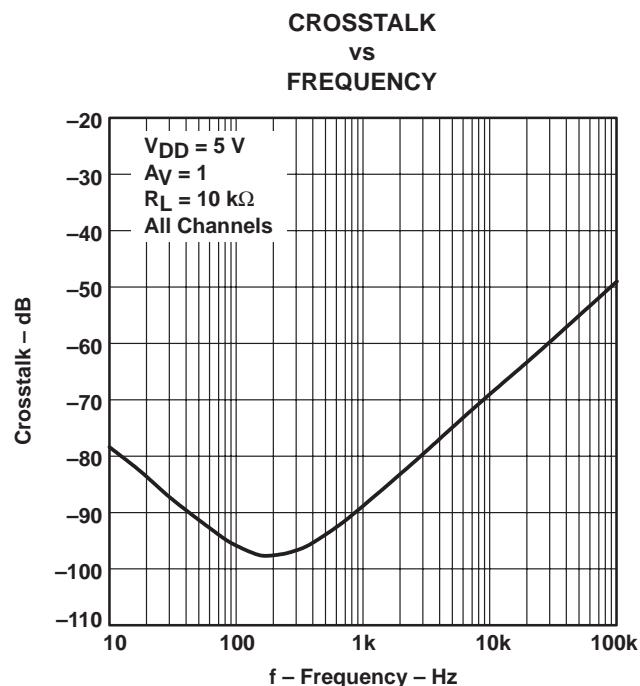


Figure 30

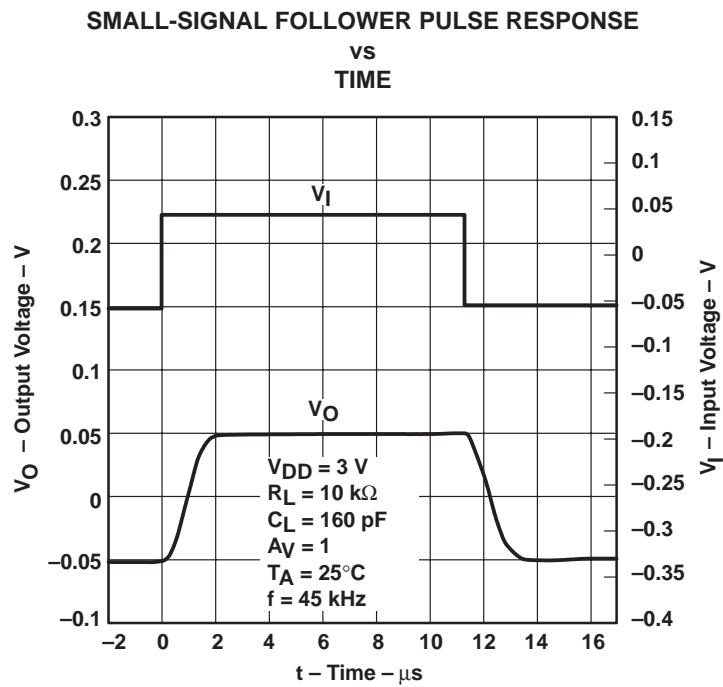


Figure 31

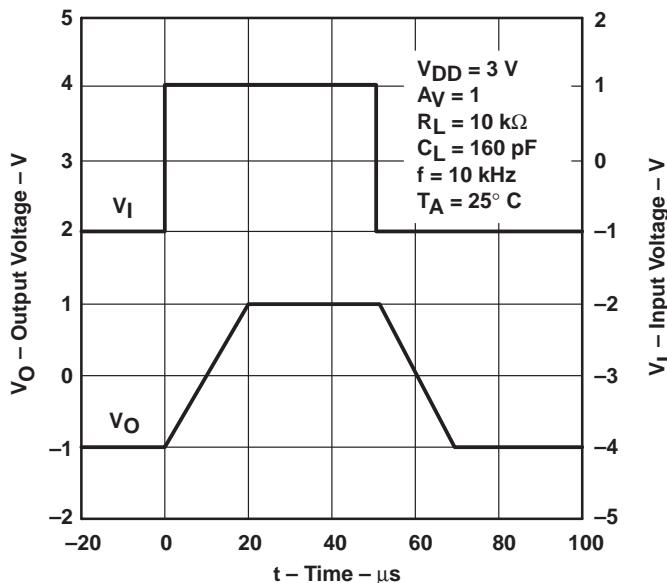
**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**

**LARGE-SIGNAL FOLLOWER PULSE RESPONSE**

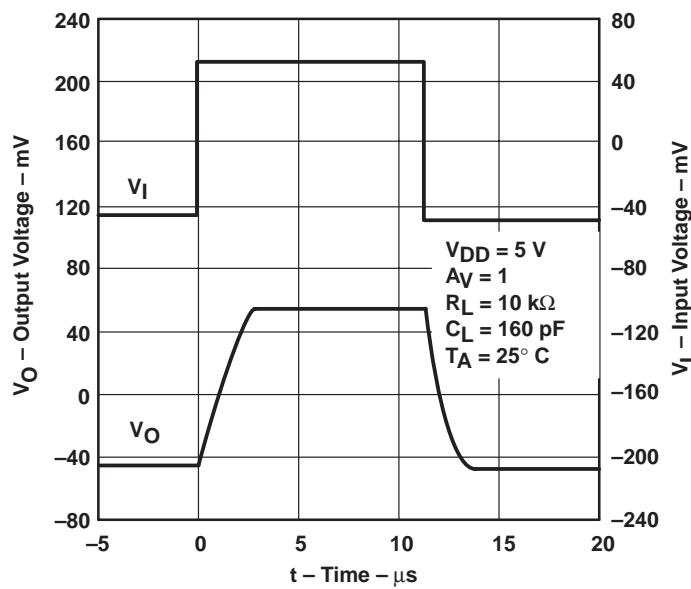
vs  
TIME



**Figure 32**

**SMALL-SIGNAL FOLLOWER PULSE RESPONSE**

vs  
TIME



**Figure 33**

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**

LARGE-SIGNAL FOLLOWER PULSE RESPONSE

vs  
TIME

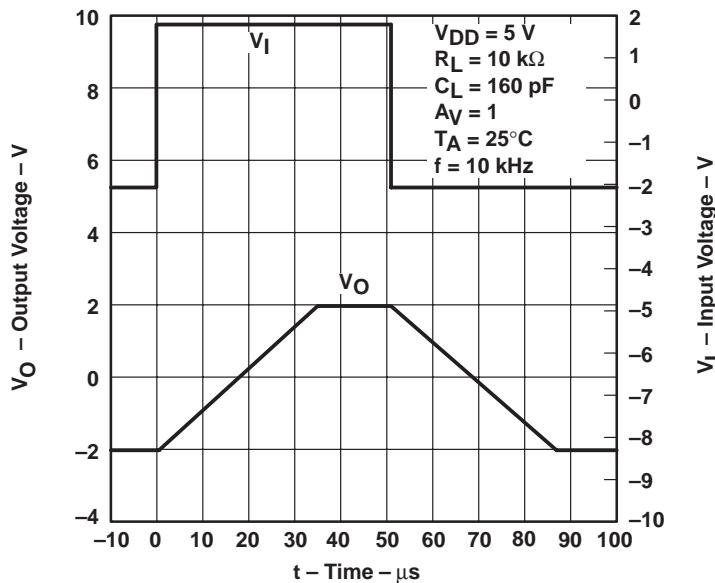


Figure 34

SHUTDOWN ON SUPPLY CURRENT

vs  
TIME

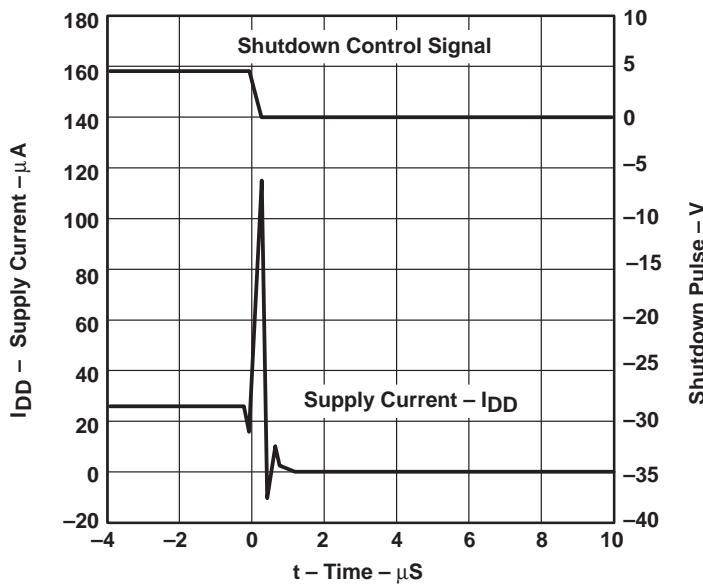
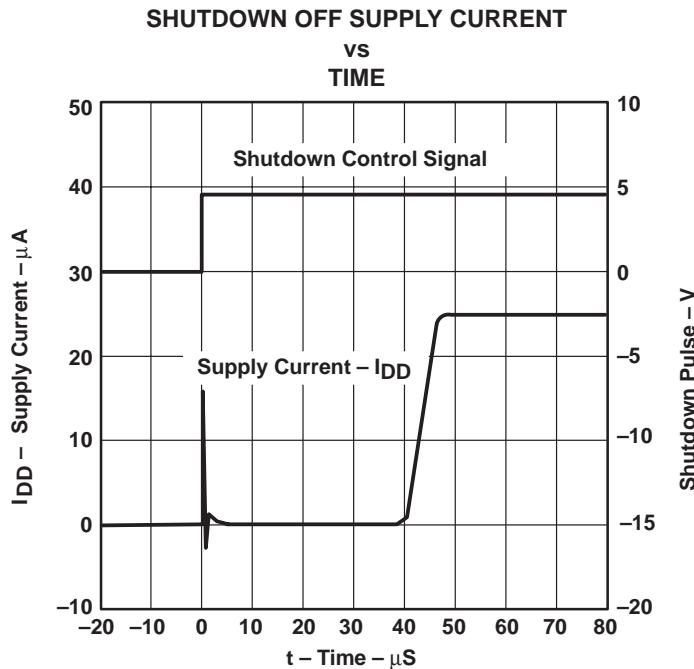


Figure 35

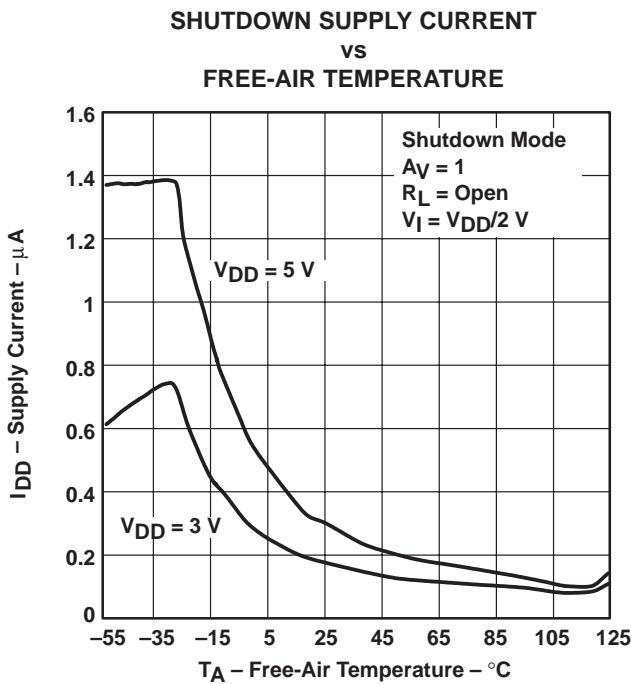
**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**



**Figure 36**



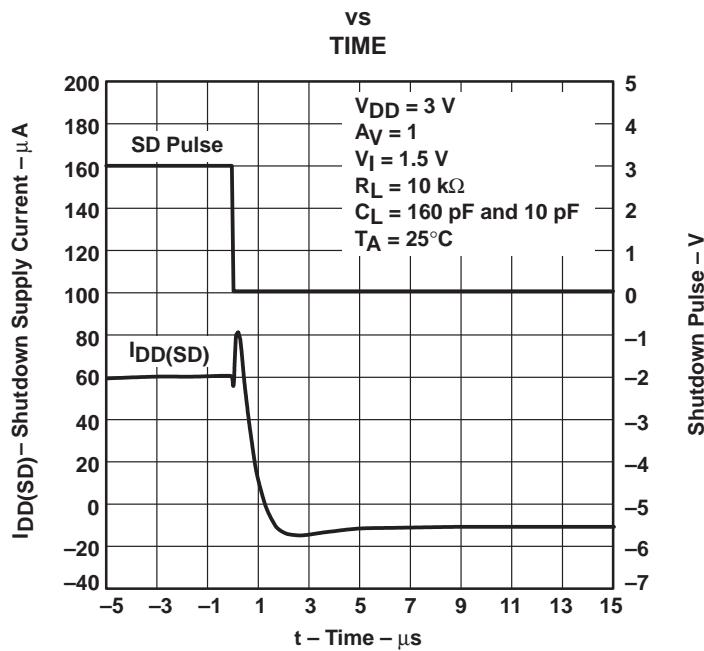
**Figure 37**

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

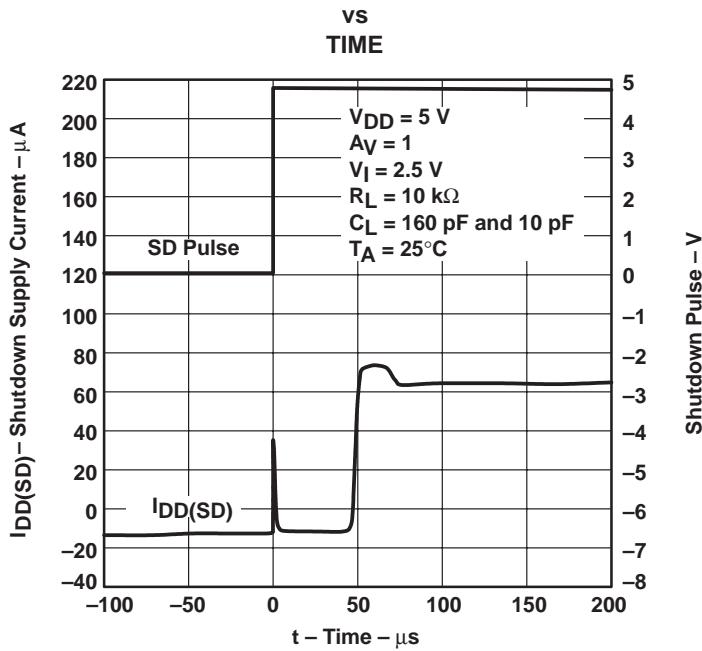
**TYPICAL CHARACTERISTICS**

**SHUTDOWN SUPPLY CURRENT AND SHUTDOWN PULSE**



**Figure 38**

**SHUTDOWN SUPPLY CURRENT AND SHUTDOWN PULSE**



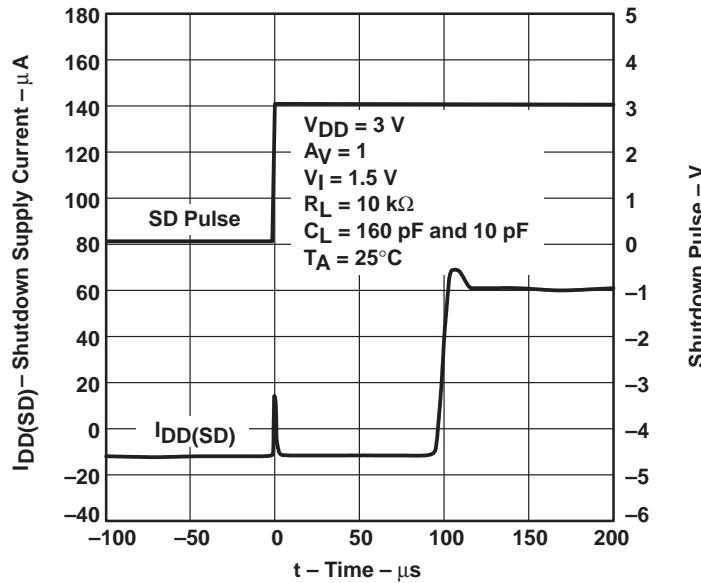
**Figure 39**

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

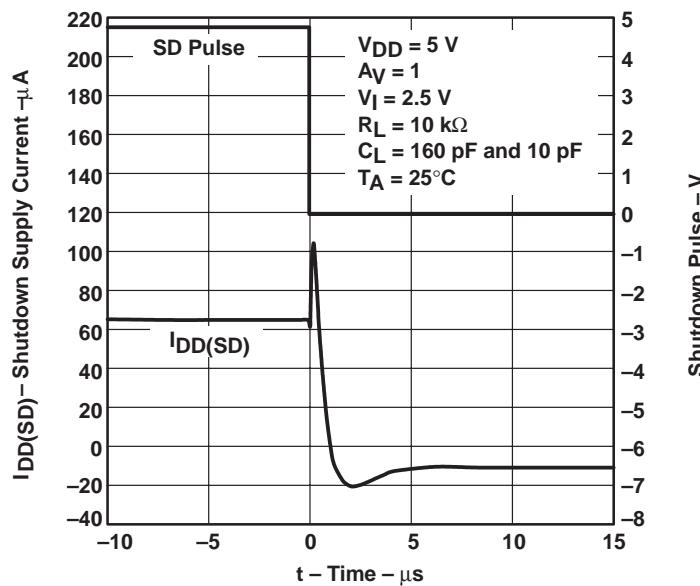
**TYPICAL CHARACTERISTICS**

**SHUTDOWN SUPPLY CURRENT AND SHUTDOWN PULSE  
vs  
TIME**



**Figure 40**

**SHUTDOWN SUPPLY CURRENT AND SHUTDOWN PULSE  
vs  
TIME**



**Figure 41**

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**

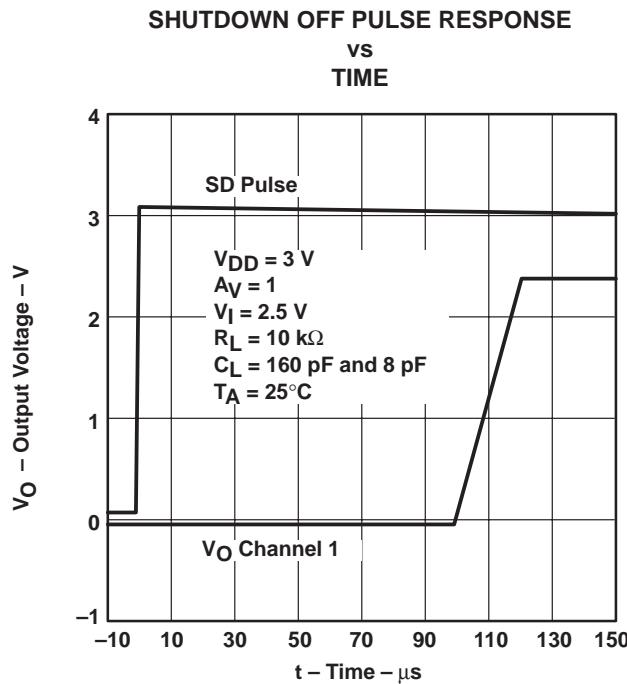


Figure 42

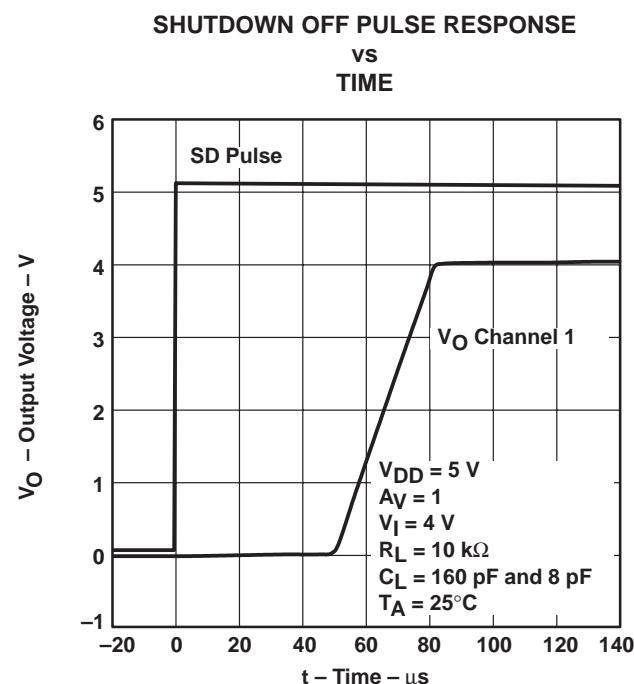


Figure 43

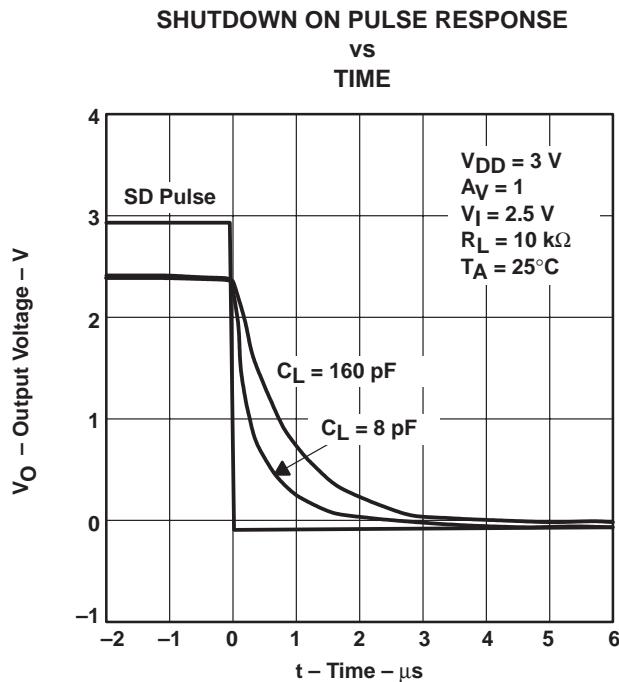


Figure 44

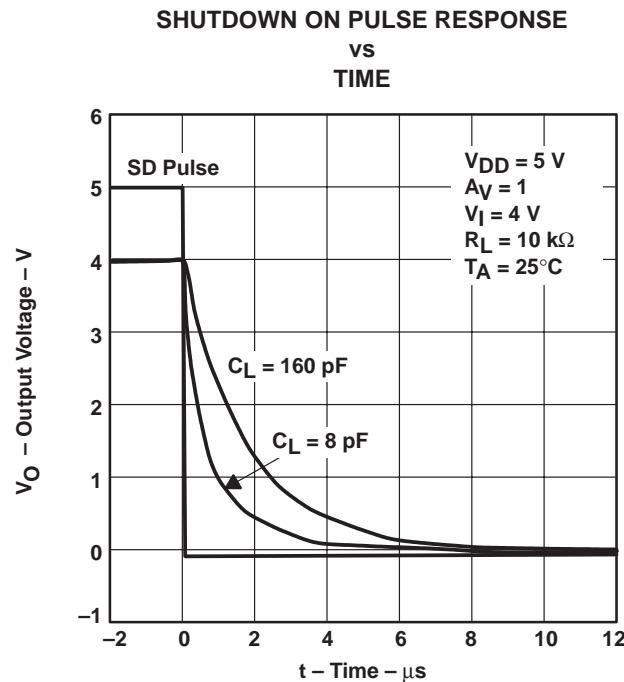
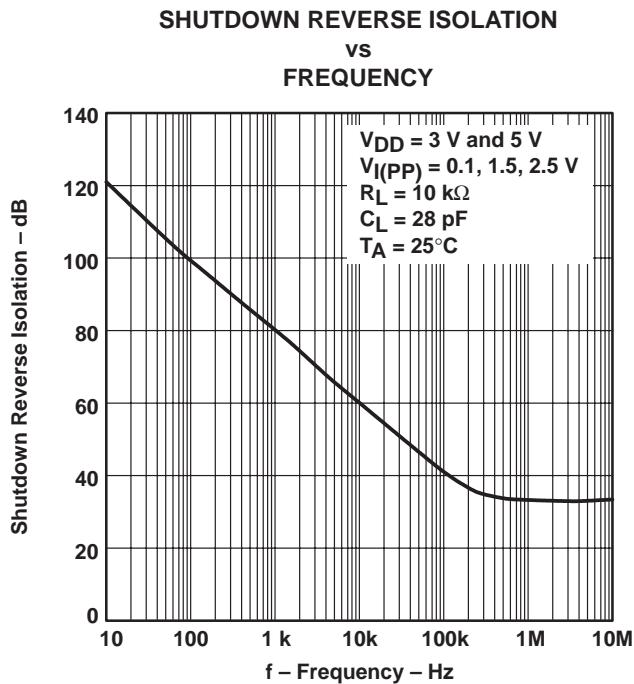


Figure 45

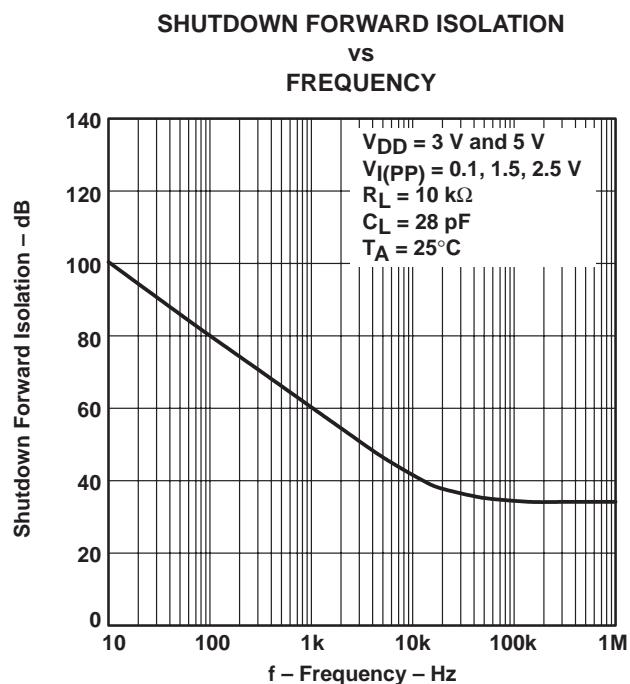
**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**TYPICAL CHARACTERISTICS**



**Figure 46**



**Figure 47**

# TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS WITH SHUTDOWN

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

## APPLICATION INFORMATION

### general power dissipation considerations

For a given  $\theta_{JA}$ , the maximum power dissipation is shown in Figure 48 and is calculated by the following formula:

$$P_D = \left( \frac{T_{MAX} - T_A}{\theta_{JA}} \right)$$

Where:

$P_D$  = Maximum power dissipation of TLV245x IC (watts)

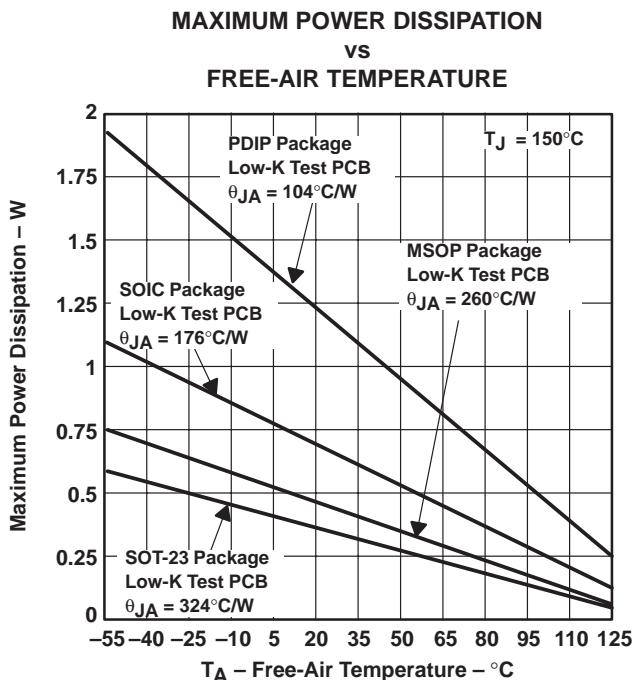
$T_{MAX}$  = Absolute maximum junction temperature (150°C)

$T_A$  = Free-ambient air temperature (°C)

$\theta_{JA}$  =  $\theta_{JC} + \theta_{CA}$

$\theta_{JC}$  = Thermal coefficient from junction to case

$\theta_{CA}$  = Thermal coefficient from case to ambient air (°C/W)



NOTE A: Results are with no air flow and using JEDEC Standard Low-K test PCB.

**Figure 48. Maximum Power Dissipation vs Free-Air Temperature**

# TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS WITH SHUTDOWN

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

## APPLICATION INFORMATION

### shutdown function

Three members of the TLV245x family (TLV2450/3/5) have a shutdown terminal for conserving battery life in portable applications. When the shutdown terminal is tied low, the supply current is reduced to 16 nA/channel, the amplifier is disabled, and the outputs are placed in a high impedance mode. To enable the amplifier, the shutdown terminal can either be left floating or pulled high. When the shutdown terminal is left floating, care should be taken to ensure that parasitic leakage current at the shutdown terminal does not inadvertently place the operational amplifier into shutdown. The shutdown terminal threshold is always referenced to  $V_{DD}/2$ . Therefore, when operating the device with split supply voltages (e.g.  $\pm 2.5$  V), the shutdown terminal needs to be pulled to  $V_{DD}-$  (not GND) to disable the operational amplifier.

The amplifier's output with a shutdown pulse is shown in Figures 42, 43, 44, and 45. The amplifier is powered with a single 5-V supply and configured as a noninverting configuration with a gain of 5. The amplifier turnon and turnoff times are measured from the 50% point of the shutdown pulse to the 50% point of the output waveform. The times for the single, dual, and quad are listed in the data tables.

Figures 46 and 47 show the amplifier's forward and reverse isolation in shutdown. The operational amplifier is powered by  $\pm 1.35$ -V supplies and configured as a voltage follower ( $A_V = 1$ ). The isolation performance is plotted across frequency using 0.1- $V_{PP}$ , 1.5- $V_{PP}$ , and 2.5- $V_{PP}$  input signals. During normal operation, the amplifier would not be able to handle a 2.5- $V_{PP}$  input signal with a supply voltage of  $\pm 1.35$  V since it exceeds the common-mode input voltage range ( $V_{ICR}$ ). However, this curve illustrates that the amplifier remains in shutdown even under a worst case scenario.

### macromodel information

Macromodel information provided was derived using Microsim *Parts*<sup>TM</sup>, the model generation software used with Microsim *PSpice*<sup>TM</sup>. The Boyle macromodel (see Note 1) and subcircuit in Figure 49 are generated using the TLV245x typical electrical and operating characteristics at  $T_A = 25^\circ\text{C}$ . Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

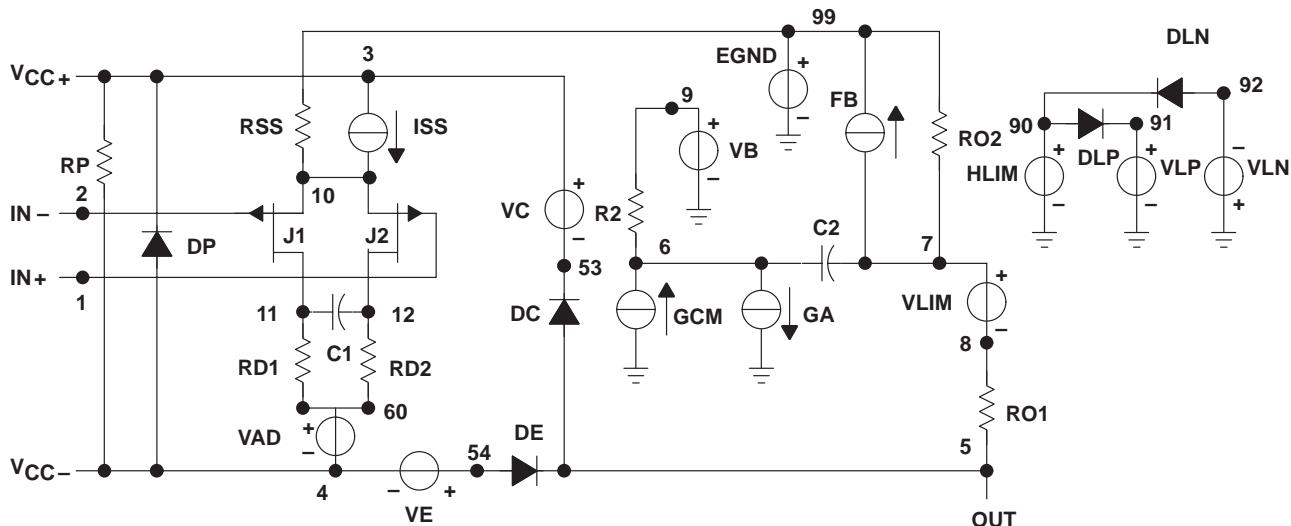
- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 1: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers," *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).

# TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS WITH SHUTDOWN

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

## APPLICATION INFORMATION



\* AMP\_TLV2450-X operational amplifier "macromodel" subcircuit  
\* created using Parts release 8.0 on 10/12/98 at 11:06

\* Parts is a MicroSim product.

\* connections: non-inverting input

\* | inverting input

\* || positive power supply

\* || negative power supply

\* ||| output

\* .subckt AMP\_TLV2450-X 1 2 3 4 5

c1	11	12	354.48E-15
c2	6	7	7.5000E-12
cee	10	99	42.237E-15
dc	5	53	dy
de	54	5	dy
dip	90	91	dx
dln	92	90	dx
dp	4	3	dx
egnd	99	0	poly(2) (3,0) (4,0) 0 .5 .5
fb	7	99	poly(5) vb vc ve vlp vln 0
	+ 207.31E6	-1E3 1E3	210E6 -210E6
ga	6	0	11 12 15.254E-6
gcm	0	6	10 99 48.237E-12

iee	10	4	dc 938.61E-9
hlim	90	0	vlim 1K
q1	11	2	13 qx1
q2	12	1	14 qx2
r2	6	9	100.00E3
rc1	3	11	65.557E3
rc2	3	12	65.557E3
re1	13	10	10.367E3
re2	14	10	10.367E3
ree	10	99	213.08E6
ro1	8	5	10
ro2	7	99	10
rp	3	4	147.06
vb	9	0	dc 0
vc	3	53	dc .82
ve	54	4	dc .82
vlim	7	8	dc 0
vlp	91	0	dc 38
vln	0	92	dc 38
.model	dx	D(Is=800.00E-18)	
.model	dy	D(Is=800.00E-18 Rs=1m Cjo=10p)	
.model	qx1	NPN(Is=800.00E-18 Bf=843.08)	
.model	qx2	NPN(Is=800.0000E-18 Bf=843.08)	
.ends			

\* Schematics Subcircuit \*

.subckt TLV2450\_ver1 Vout Vdd GND V- V- SD

```

S_S2    $N_0001 GND SD GND S2
RS_S2   SD GND 1G
.MODEL S2 VSWITCH Roff=1e6 Ron=1.0 Voff=0.0
+ Von=1.0
S_S1    $N_0002 VDD SD GND S1
RS_S1   SD GND 1G
.MODEL S1 VSWITCH Roff=1e6 Ron=1.0 Voff=0.0
+ Von=1.0
S_S3    Vout $N_0003 SD GND S3
RS_S3   SD GND 1G
.MODEL S3 VSWITCH Roff=1e6 Ron=1.0 Voff=0.0
+ Von=1.0
X_SUB_U1  V+ V- GND Vout AMP_TLV2450-X
.ENDS  tlv2450_ver1

```

\* Schematics Subcircuit \*

.subckt TLV2451\_ver1 V+ V- Vout Vdd GND

\*

```

X_SUB_U1  V+ V- GND Vout AMP_TLV2450-X
.ENDS  tlv2451_ver1

```

Figure 49. Boyle Macromodel and Subcircuit

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

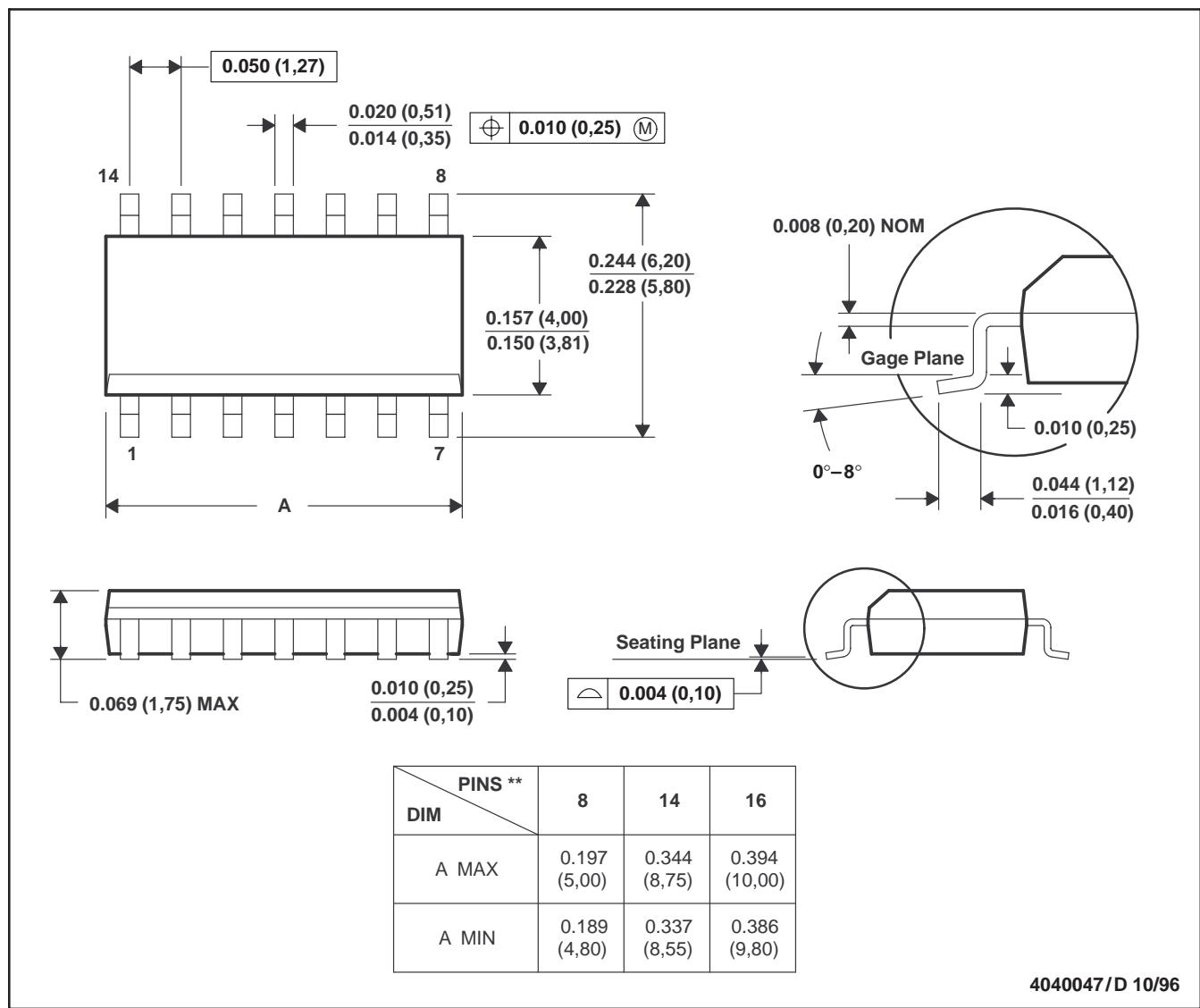
SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**MECHANICAL DATA**

**D (R-PDSO-G\*\*)**

**PLASTIC SMALL-OUTLINE PACKAGE**

14 PIN SHOWN



4040047/D 10/96

- NOTES: B. All linear dimensions are in inches (millimeters).  
 C. This drawing is subject to change without notice.  
 D. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0.15).  
 E. Falls within JEDEC MS-012

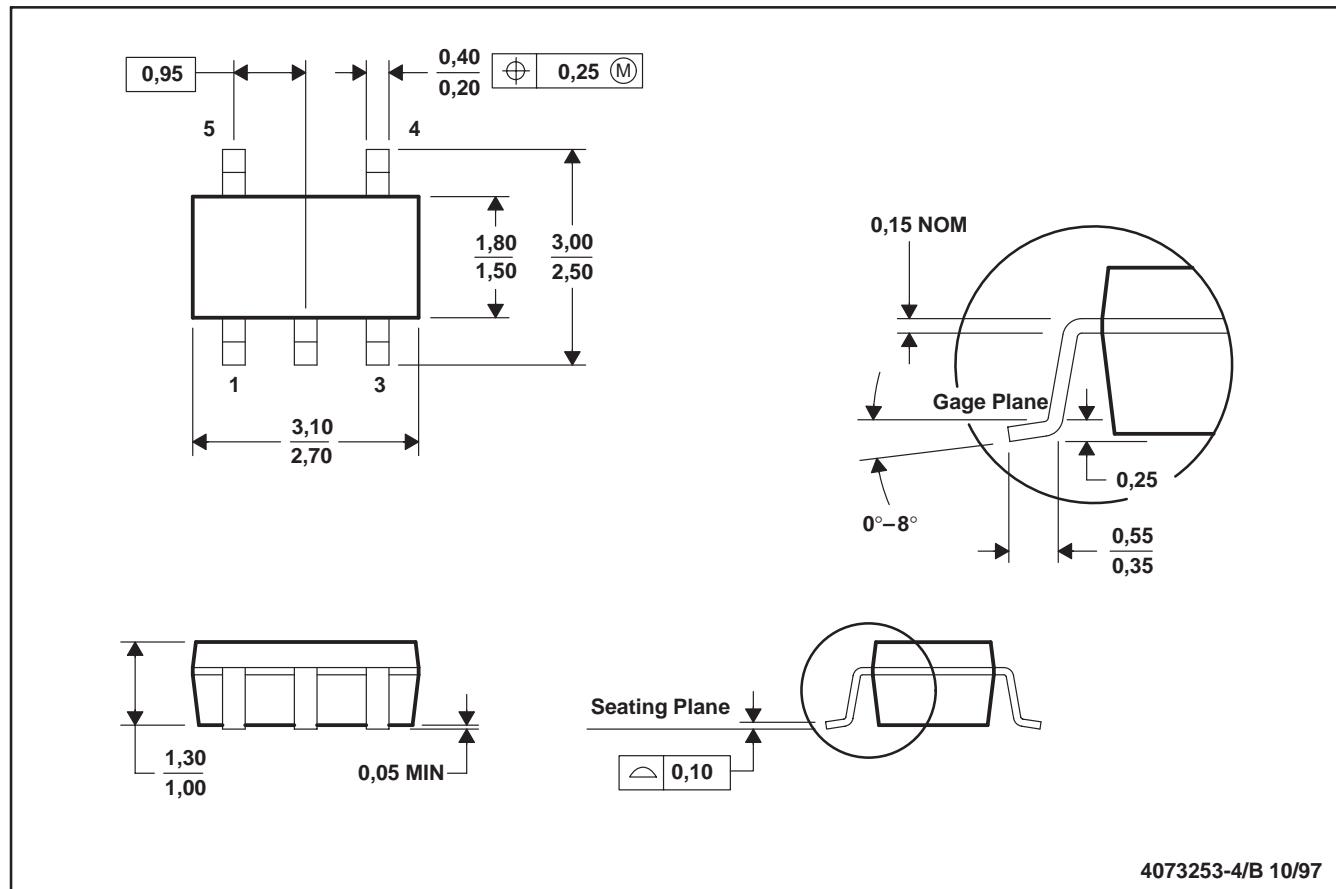
**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**MECHANICAL INFORMATION**

**DBV (R-PDSO-G5)**

**PLASTIC SMALL-OUTLINE PACKAGE**



4073253-4/B 10/97

- NOTES: A. All linear dimensions are in millimeters.  
B. This drawing is subject to change without notice.  
C. Body dimensions include mold flash or protrusion.

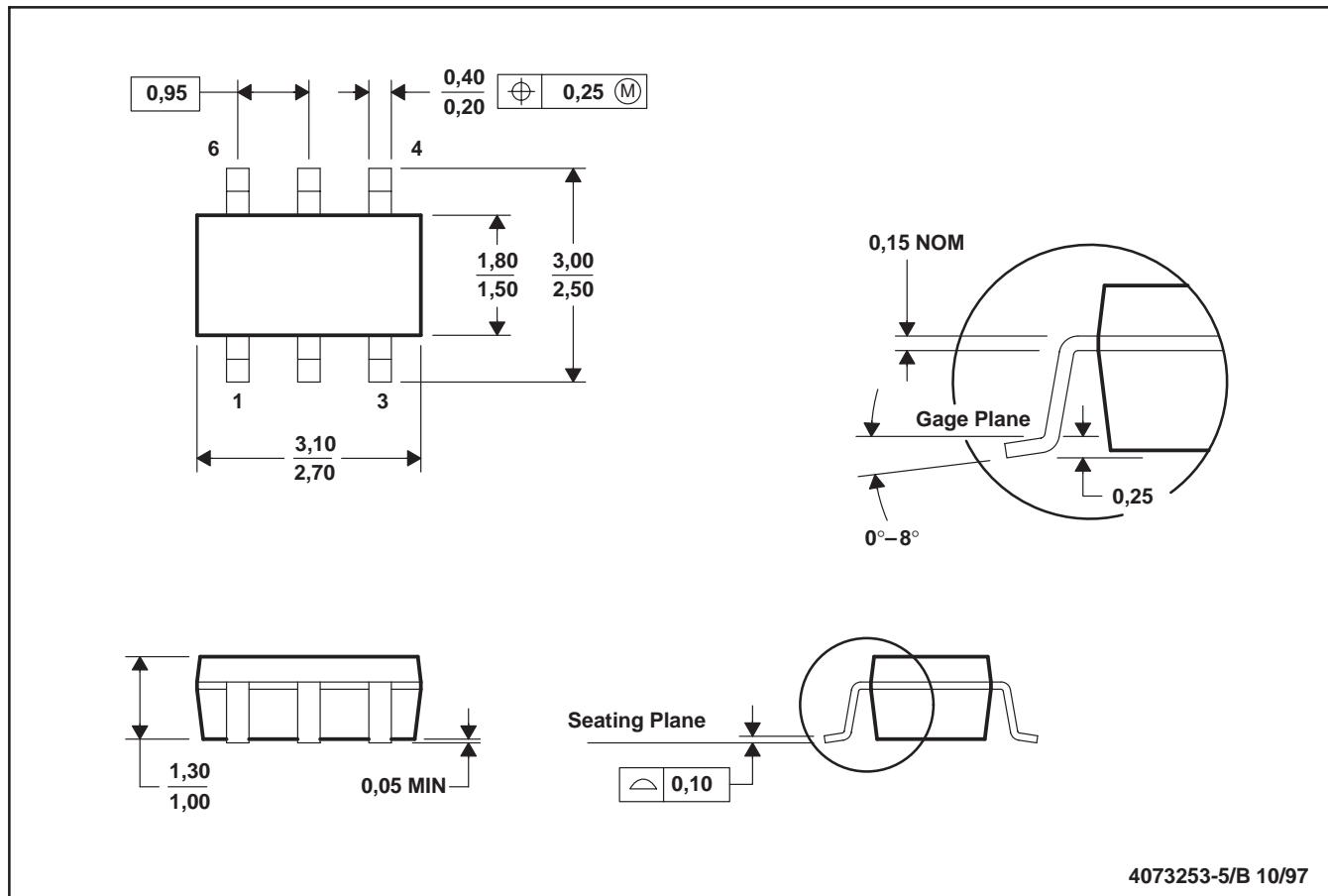
**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**MECHANICAL INFORMATION**

**DBV (R-PDSO-G6)**

**PLASTIC SMALL-OUTLINE PACKAGE**



- NOTES: A. All linear dimensions are in millimeters.  
B. This drawing is subject to change without notice.  
C. Body dimensions include mold flash or protrusion.

4073253-5/B 10/97

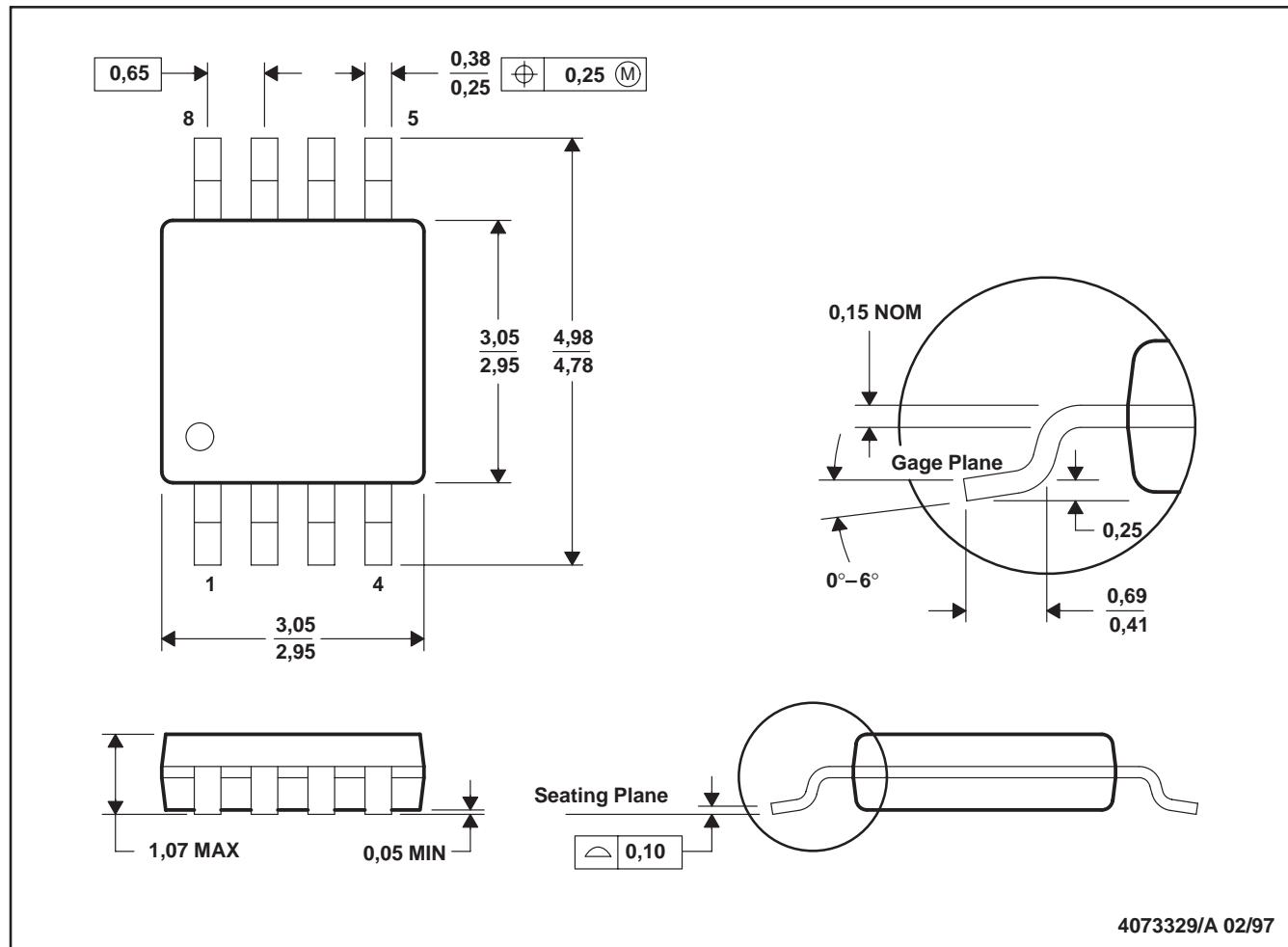
**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**MECHANICAL INFORMATION**

**DGK (R-PDSO-G8)**

**PLASTIC SMALL-OUTLINE PACKAGE**



NOTES: A. All linear dimensions are in millimeters.  
B. This drawing is subject to change without notice.  
C. Body dimensions do not include mold flash or protrusion.

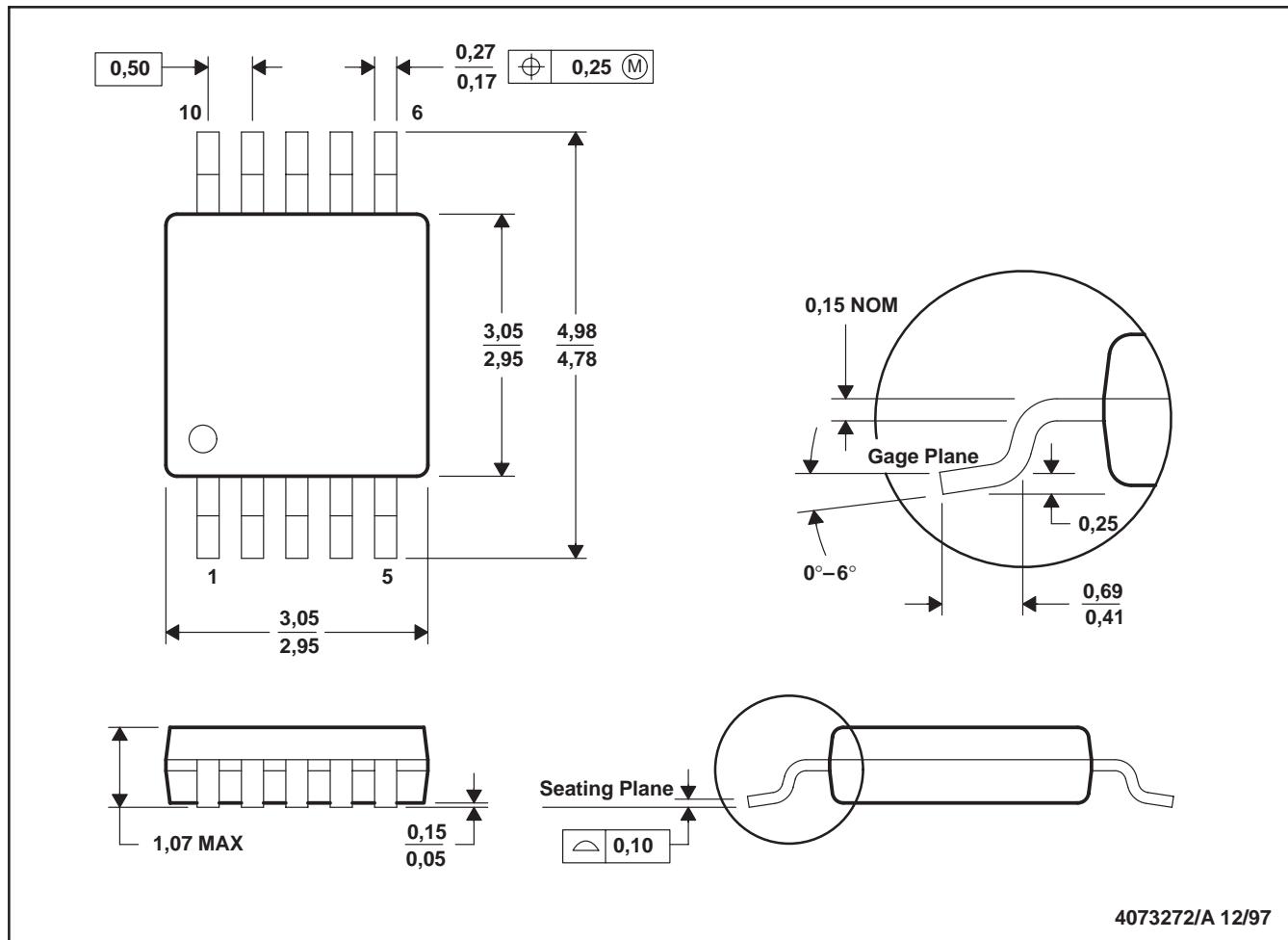
**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**MECHANICAL INFORMATION**

**DGS (S-PDSO-G10)**

**PLASTIC SMALL-OUTLINE PACKAGE**



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion.

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

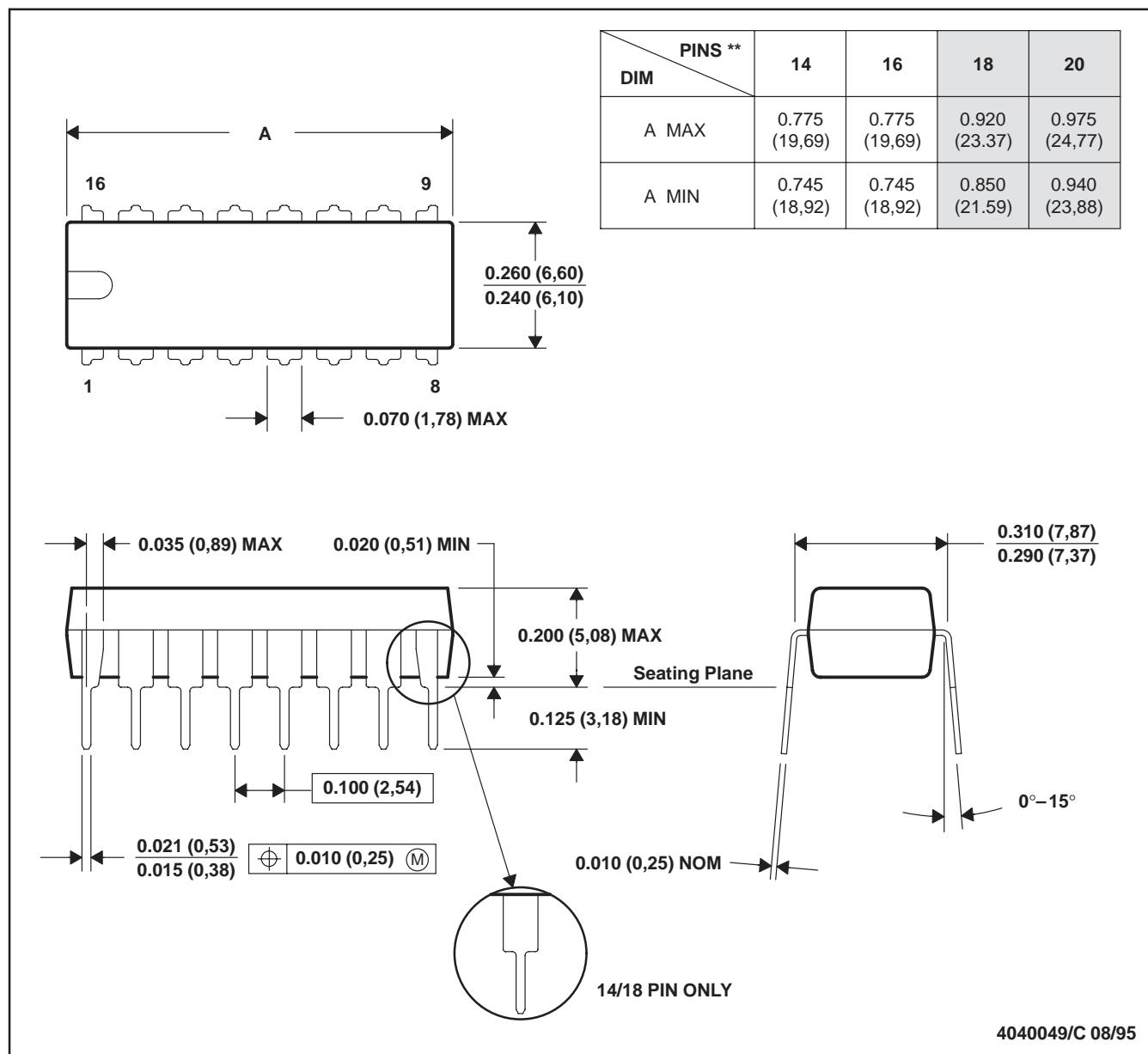
SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**MECHANICAL INFORMATION**

**N (R-PDIP-T\*\*)**

16 PIN SHOWN

**PLASTIC DUAL-IN-LINE PACKAGE**



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-001 (20 pin package is shorter than MS-001.)

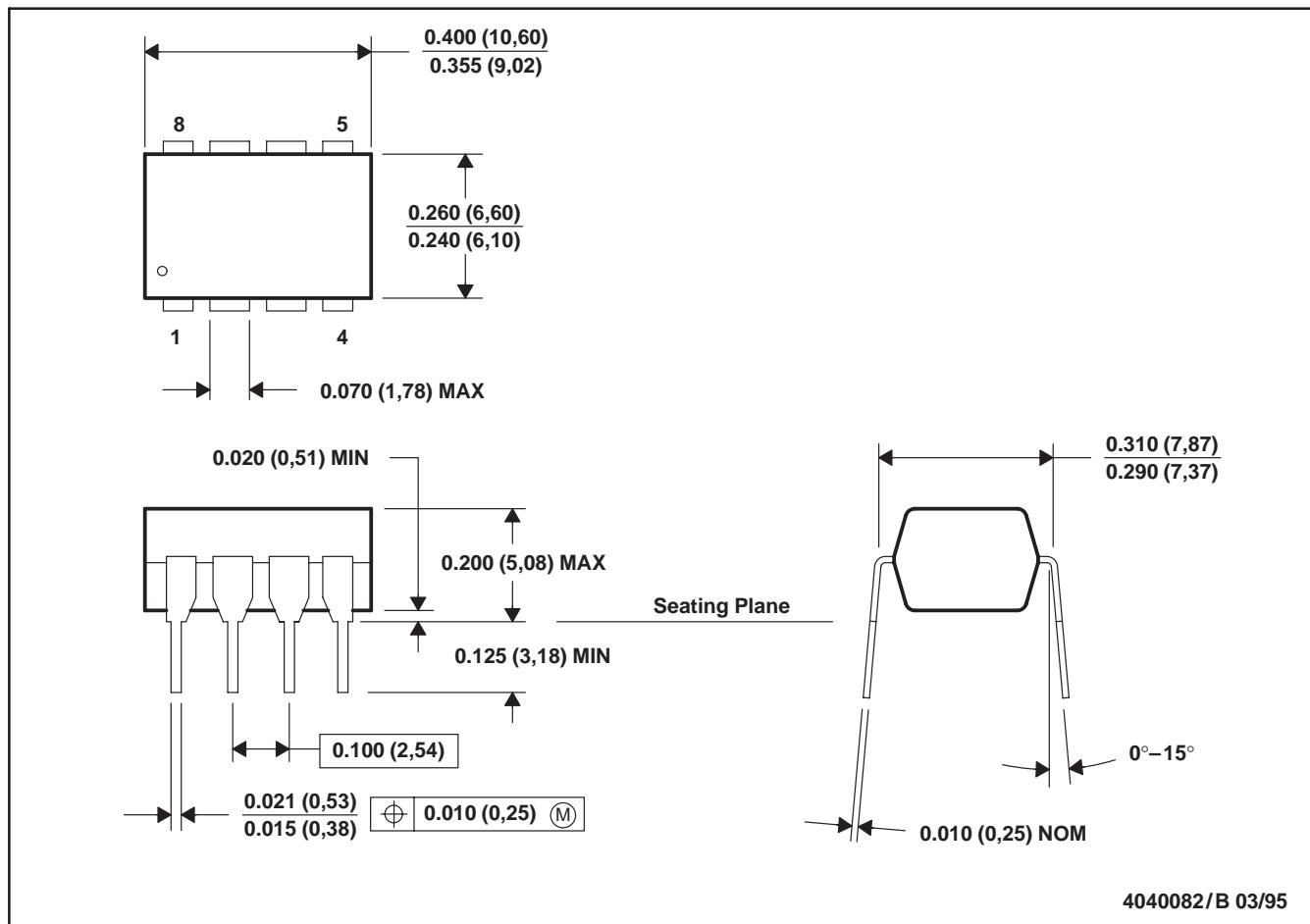
**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**MECHANICAL INFORMATION**

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



4040082/B 03/95

- NOTES: A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.  
C. Falls within JEDEC MS-001

**TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA  
FAMILY OF 23- $\mu$ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT  
OPERATIONAL AMPLIFIERS WITH SHUTDOWN**

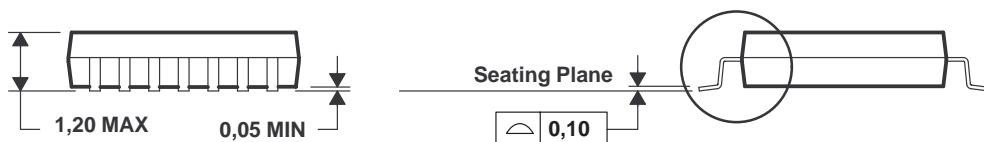
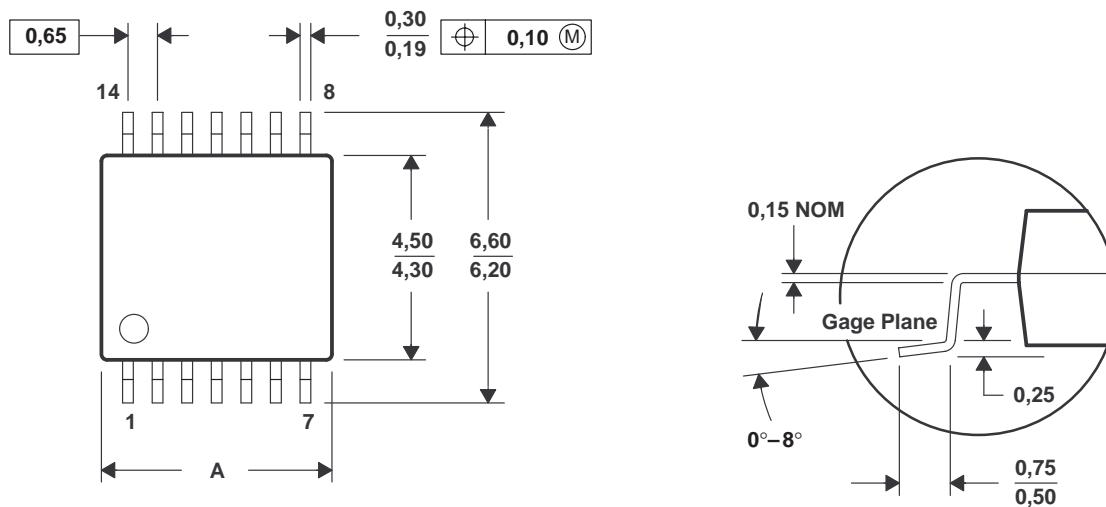
SLOS218B – DECEMBER 1998 – REVISED JUNE 1999

**MECHANICAL INFORMATION**

**PW (R-PDSO-G\*\*)**

**14 PIN SHOWN**

**PLASTIC SMALL-OUTLINE PACKAGE**



PINS ** DIM	8	14	16	20	24	28
A MAX	3,10	5,10	5,10	6,60	7,90	9,80
A MIN	2,90	4,90	4,90	6,40	7,70	9,60

4040064/E 08/96

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

### **IMPORTANT NOTICE**

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.